



# **NEW PIXEL DETECTORS FOR ALICE AT LHC AND FOR NICA EXPERIMENTS**

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**Saint-Petersburg State University**

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# Outline



- 1. ALICE Inner Tracking System: current status and upgrade strategy**
- 2. New pixel sensors for ALICE experiment: ALICE Pixel detectors (ALPIDE family)**
- 3. Study of the characteristics of ALICE ITS pixel detectors**
- 4. Pixel detectors for NICA experiments**
- 5. Summary**

# ALICE Inner Tracking System: current status and upgrade strategy



**ALICE Pixel Detector : SPD**

first two layers : tracking

**ALICE Drift Detector: SDD**

two middle layers: tracking+ particle identification

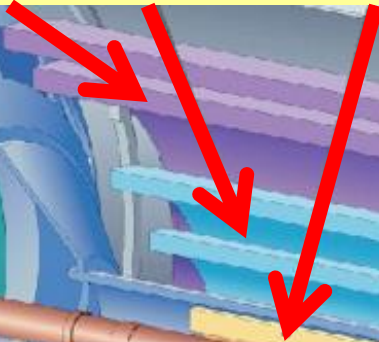
**ALICE Strip Detector: SSD**

two outer layers: tracking + particle identification



**6 cylindrical layers of Si detectors (placed coaxially around the beam pipe)**

**SSD SDD SPD**

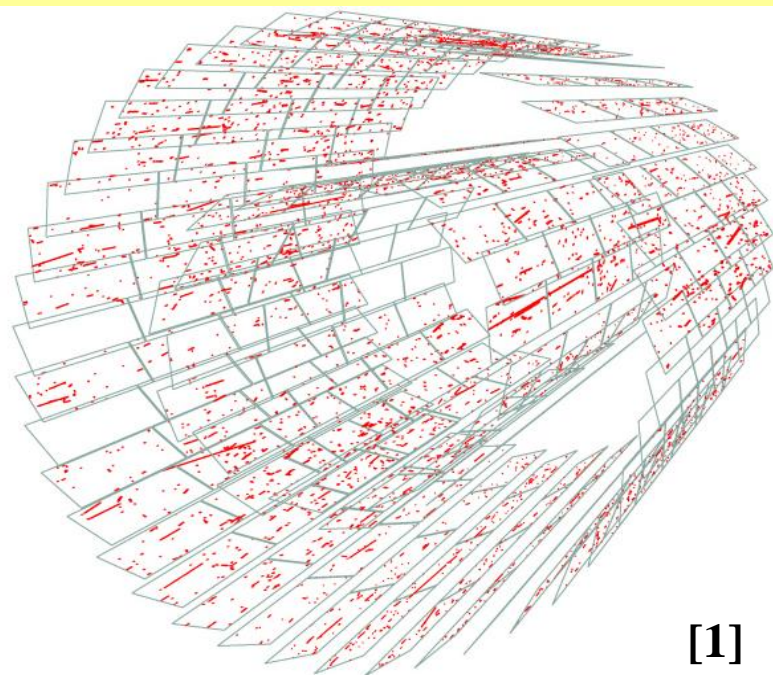


## Advantages of the Pixel Detectors

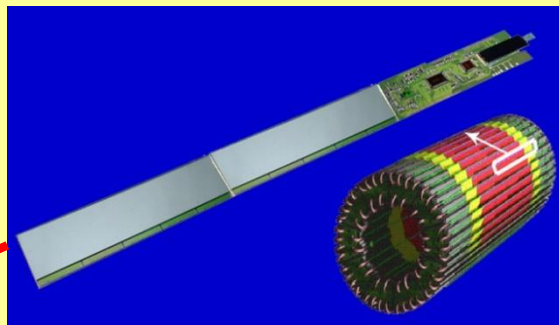
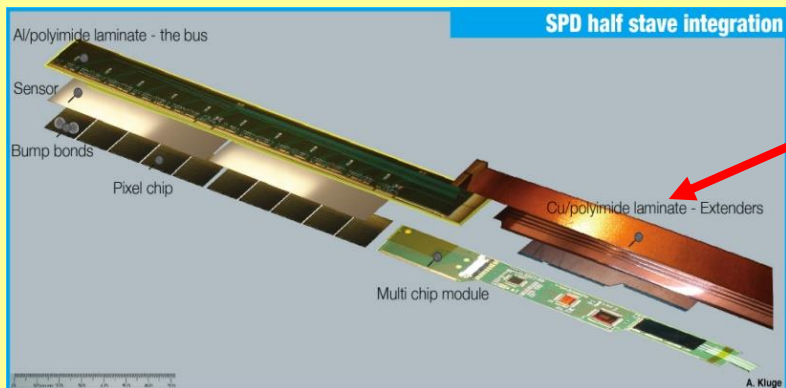
**Good position resolution: Smaller pixels, Higher integration**

**Small pixels - low capacitance - better S/N - lower analog power**

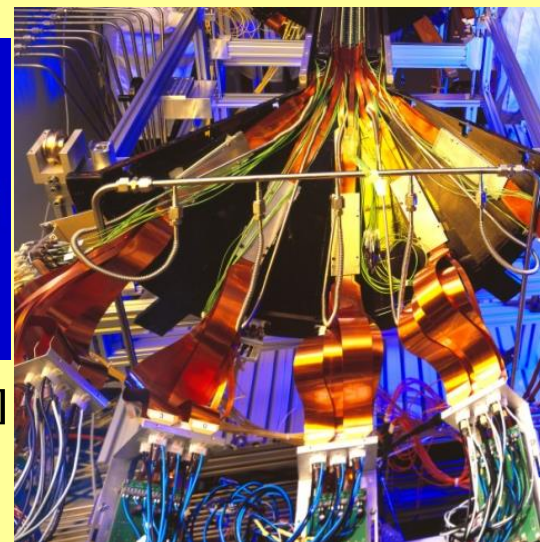
**More pixels – More logic per pixel – high integration work at higher rates and high radiation levels**



**June 2008, ALICE Silicon Pixel detector registered muon tracks produced in the injection beam line of the LHC near Point 2**



ALICE silicon pixel detector [1]





## Limitations of current ITS:

1. Read-out capabilities limited at 1kHz for Pb-Pb collisions;
2. Pointing resolution of the present ITS restricts the range of measurements.  
It is adequate for the study of charm and beauty mesons at  $p_T > 1 \text{ GeV}/c$ , but at lower  $p_T$  the statistical significance becomes insufficient for currently achievable data sets;
3. Vertices of charmed baryons are currently not feasible in Pb-Pb collisions. The mean proper decay length  $\sim 60 \mu\text{m}$ , which is lower than the pointing resolution of the current ITS in the  $p_T$  range of most of the  $\Lambda_c^+ \rightarrow p K^- \pi^+$  daughter particles ( $< 1 \text{ GeV}/c$ );
4. For the same reasons study of beauty mesons, beauty baryons, and of hadrons with more than one heavy quark is beyond reach of the current detector.

## Motivations for upgrade:

1. Increase vertex resolution
2. Improve tracking efficiency and  $p_T$  resolution at low  $p_T$ :  
allow improvement of the resolution of the track impact parameter by a factor of three or better (at  $p_T = 1 \text{ GeV}/c$ ) with respect to the present ITS
3. Increase readout rate capabilities:  
readout Pb-Pb interactions at  $> 100 \text{ kHz}$ , readout pp interactions at  $> 400 \text{ kHz}$

# ALICE Inner Tracking System: current status and upgrade strategy



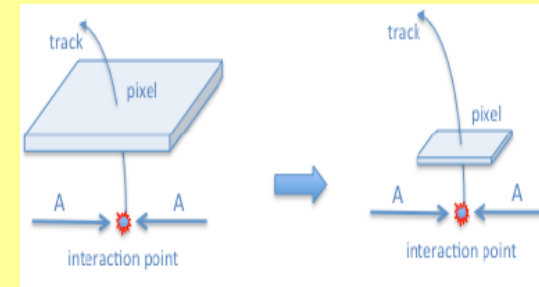
## Upgrade strategy (main points)

1. Improve impact parameter resolution by a factor of  $\sim 3$

a) First detection layer closer to the beam line: **39 mm  $\rightarrow$  22 mm**

b) Reduction of material budget: the radiation length per layer (for inner layers) **X: from 1.14 to 0.3 %X0**

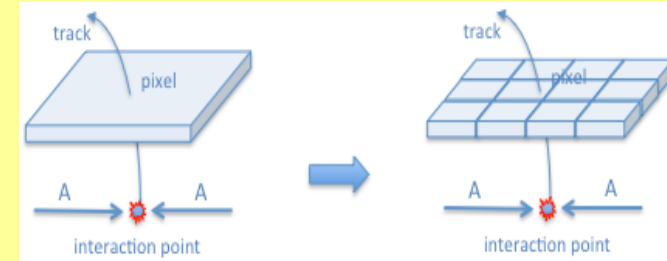
c) Reducing pixel size: **425  $\mu\text{m}$  x 50  $\mu\text{m}$   $\rightarrow$  30  $\mu\text{m}$  x 30  $\mu\text{m}$**



[2]

2. Improve tracking efficiency and  $p_T$  resolution at low  $p_T$

Increase in granularity (smaller pixels), number of layers: **6  $\rightarrow$  7, silicon drift and strips  $\rightarrow$  pixels**



**20 chan/cm<sup>3</sup>  $\rightarrow$  2000 pixel/cm<sup>3</sup>**

3. Fast readout

readout Pb-Pb interactions at  $> 100$  kHz  
(currently limited at 1kHz with full ITS)

### Also:

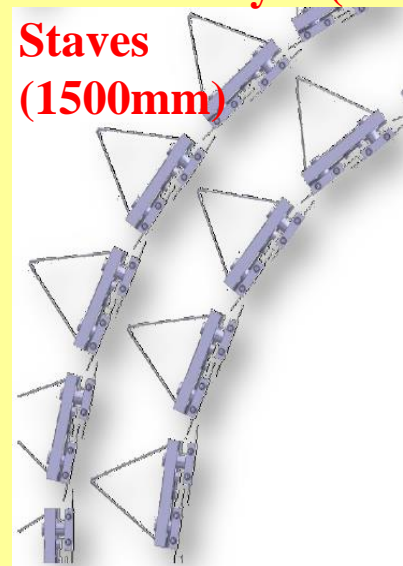
a) lower power consumption and optimized scheme for the distribution of power and signals;

b) mechanics, cooling and other detector elements will be also improved: all services are connected on one side. This allows the extraction and reinsertion of the ITS, for maintenance purposes, during the yearly LHC shutdown.

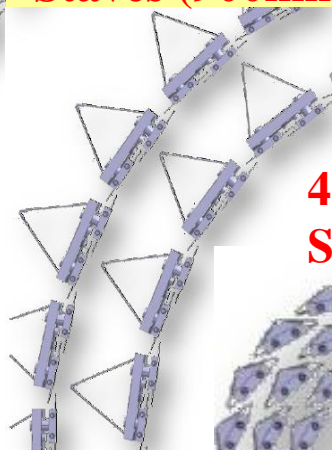


# 90 Outer layer (OL) ALICE Inner Tracking System: current status and upgrade strategy

**Staves (1500mm)**



**54 Middle layer (ML) Staves (900mm)**



**48 Inner layer (IL) Staves (290mm)**

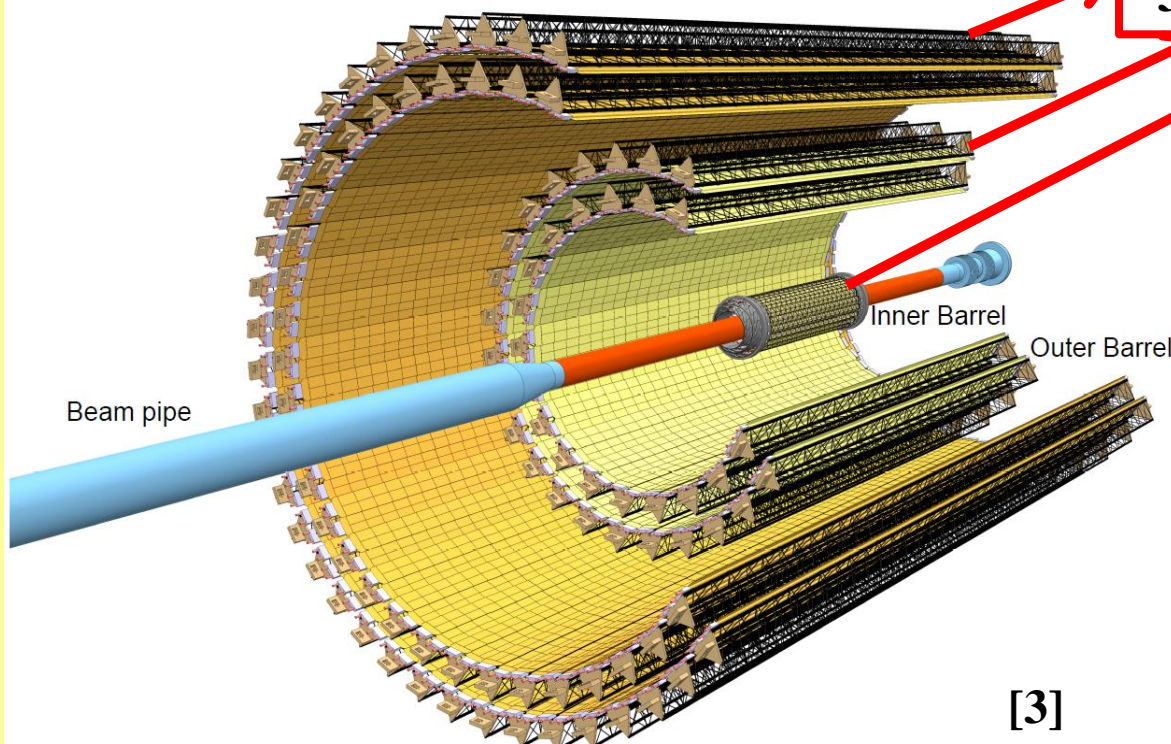


**STAVES**

**Total – 144 staves:**  
**48 (IL) – Inner Barrel**  
**54(ML) and 90(OL) – Outer Barrel**

**Stave consists of :**

- 1. Hybrid Integrated Circuit (HIC)**
- 2. Cold plate**
- 3. Space frame**



**Barrel: 7 layers of Monolithic Active Pixel Sensors (MAPS)**

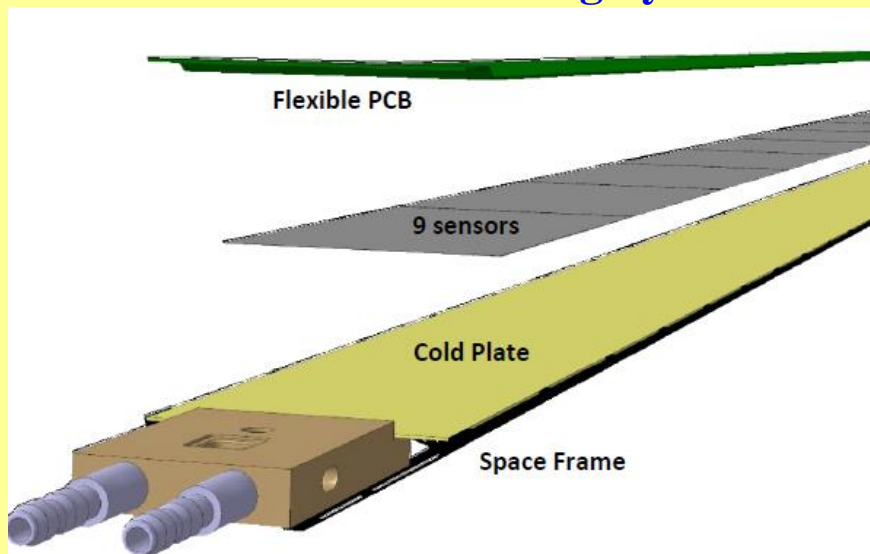
**New ITS:**

**12.5 G pixels;**

**~ 10 m<sup>2</sup> silicon active area;**

**radial coverage 22 – 400 mm.**

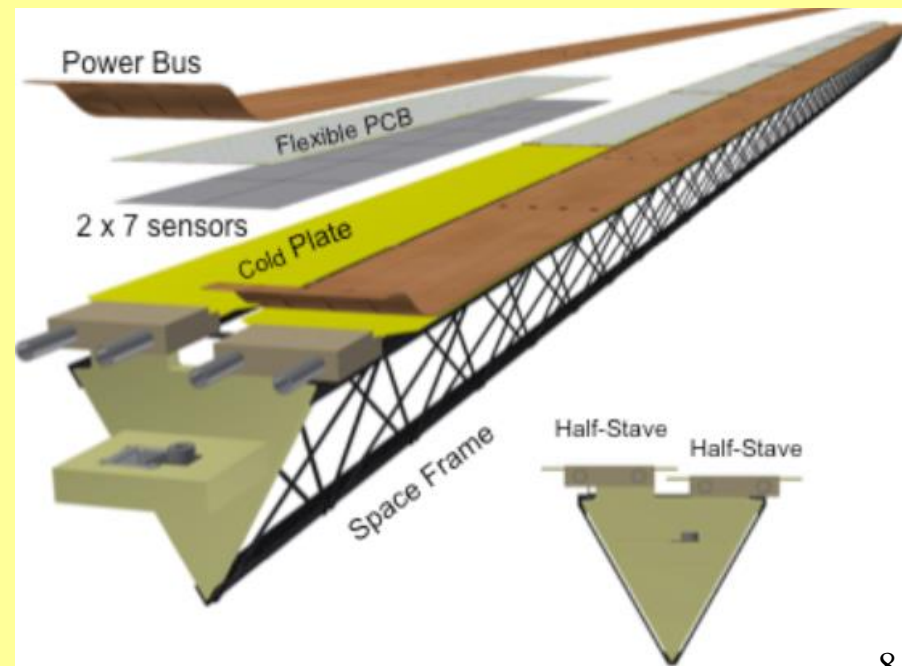
# ALICE Inner Tracking System: current status and upgrade strategy



## Inner Barrel Stave

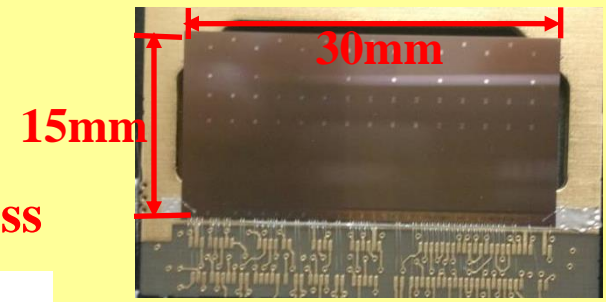


## Outer Barrel Stave

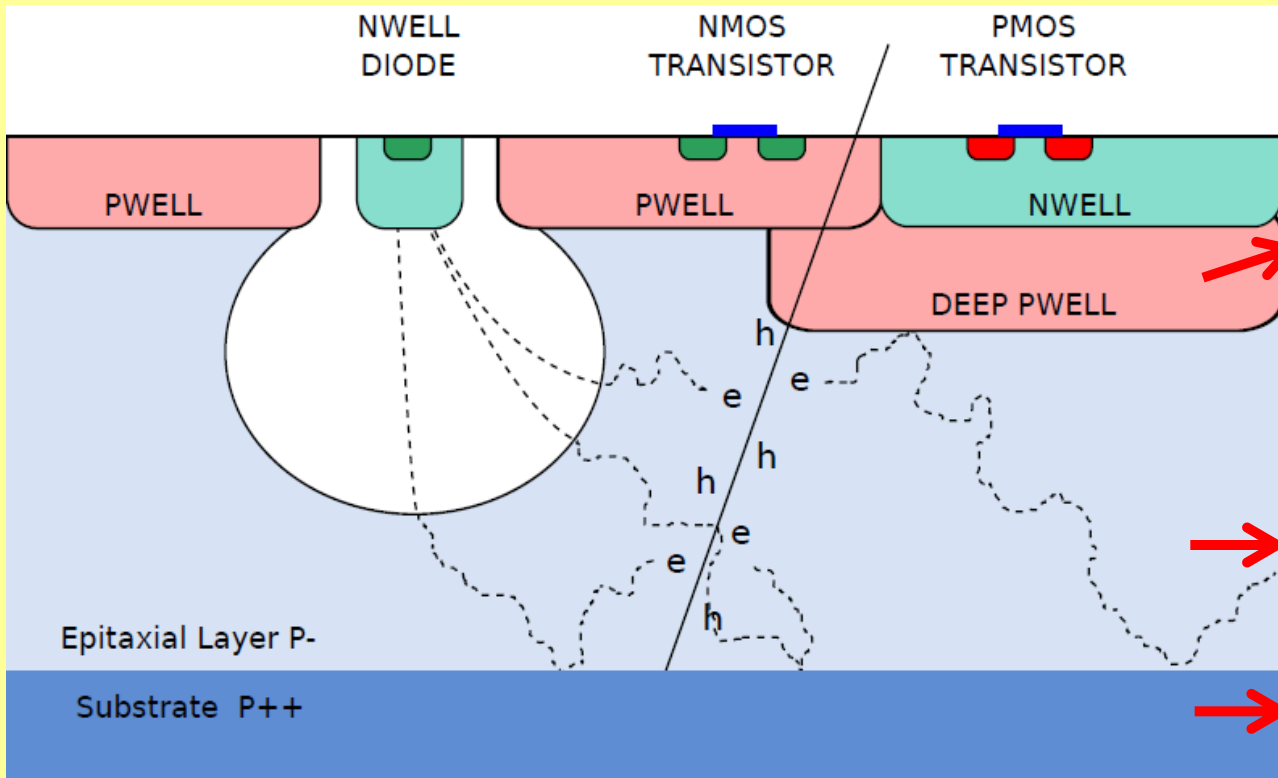




# New pixel sensors for ALICE experiment: ALICE Pixel detectors (ALPIDE family)



## MAPS using TowerJazz 180nm CMOS Imaging Process



Shields the other **nwells** different from the collection electrode, preventing these from collecting signal charge which then would be lost for readout. Full CMOS within the pixel

High resistivity ( $> 1\text{k}\Omega \cdot \text{cm}$ ) p-type epitaxial layer ( $25\mu\text{m}$ )

low-resistivity p-type substrate

Small n-well diode ( $2\text{-}3\ \mu\text{m}$  diameter),  $\sim 100$  times smaller than pixel  $\rightarrow$  low capacitance

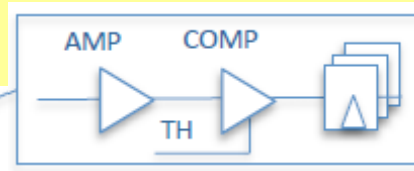
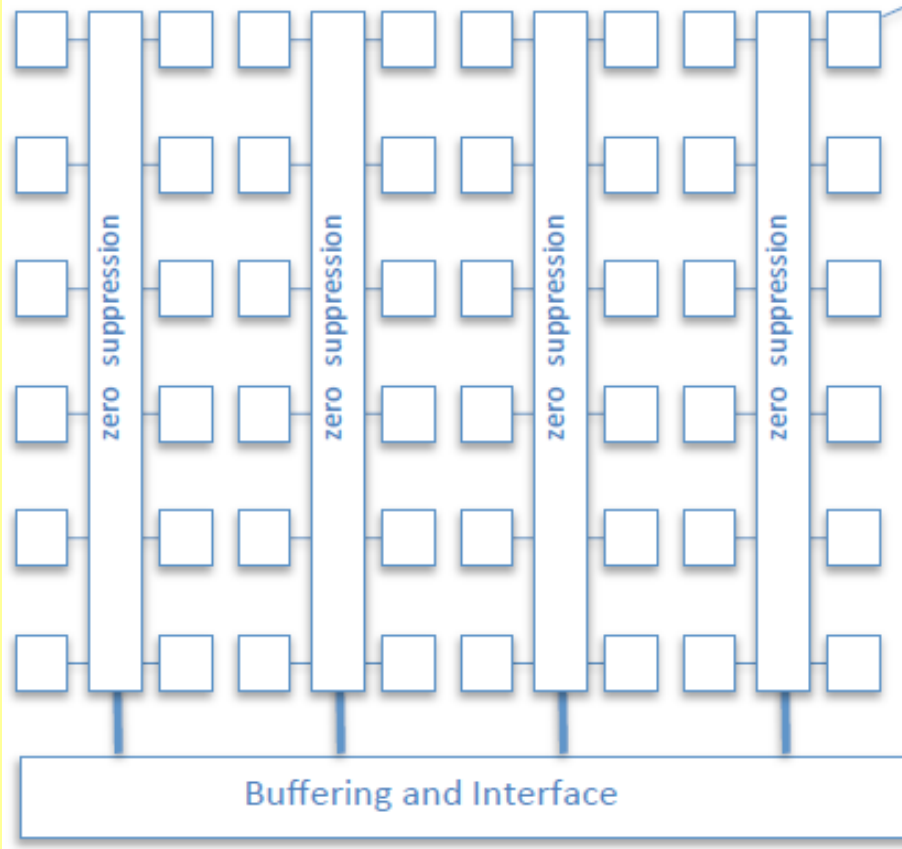
The gate oxide thickness of  $3\ \text{nm}$   $\rightarrow$  robustness to Total Ionizing Dose

Possibility to apply back bias to the substrate can be used to increase depletion zone around NWELL collection diode: S/N ratio increases, higher efficiency

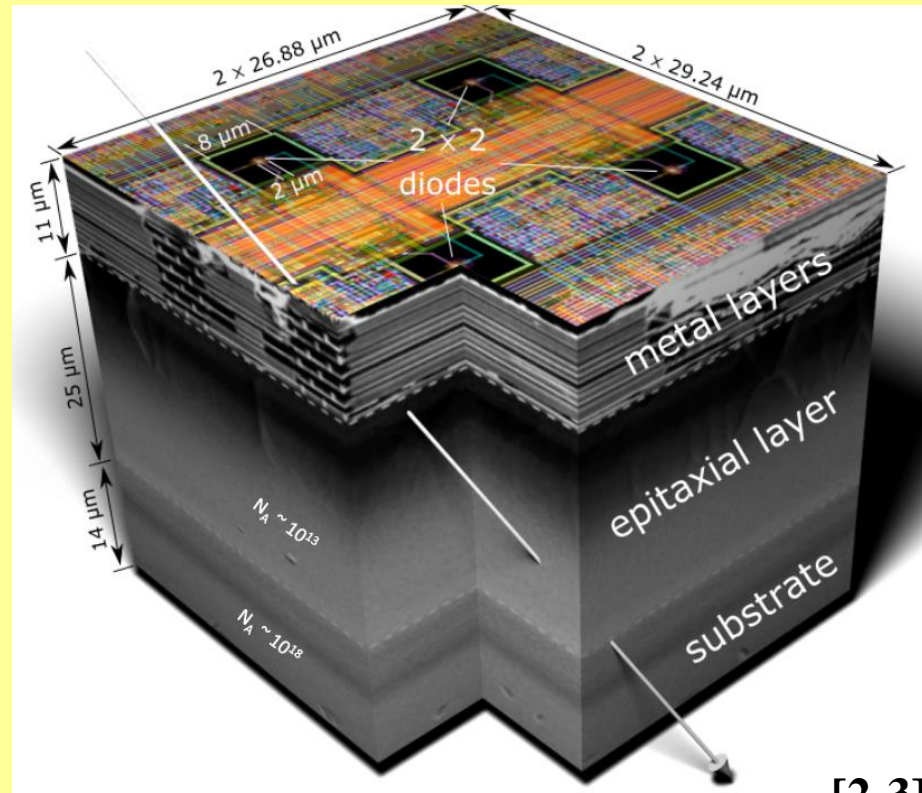
# New pixel sensors for ALICE experiment: ALICE Pixel detectors (ALPIDE family)

detectors (ALPIDE family)

## ALPIDE chip architecture



**In-pixel amplification**  
**In-pixel discrimination**  
**In-pixel (multi-) hit buffer**



The zero suppression is performed within the matrix. Address-Encoder Reset-Decoder circuit is employed. It can either be controlled by an **external trigger** signal or operated in **continuous acquisition mode**.

Power consumption **40 mW/cm<sup>2</sup>**

[2-3]

Contains a matrix of **512 × 1024 sensitive pixels**

# New pixel sensors for ALICE experiment: ALICE Pixel detectors (ALPIDE family)



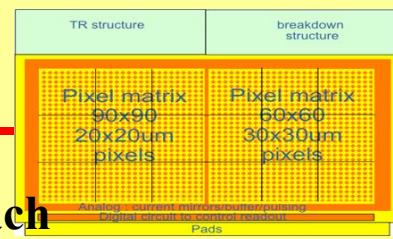
## Pixel detector general requirements (from ALICE TDR [3])

Parameter	Inner Barrel (IB)	Outer Barrel (OB)	ALPIDE Performance
Silicon thickness	50 $\mu\text{m}$	100 $\mu\text{m}$	
Chip dimension	15 mm x 30 mm	15 mm x 30 mm	
Spatial resolution	5 $\mu\text{m}$	10 $\mu\text{m}$	5 $\mu\text{m}$ (IB), 5 $\mu\text{m}$ (OB)
Power density	< 300 mW/cm <sup>2</sup>	< 100 mW/cm <sup>2</sup>	40 mW/cm <sup>2</sup> (IB), 30 mW/cm <sup>2</sup> (OB)
Max. integration time	30 $\mu\text{s}$	30 $\mu\text{s}$	10 $\mu\text{s}$
Detection efficiency	>99%	>99%	>99% <b>Upper limit!</b>
Fake-hit rate	<10 <sup>-5</sup> (TDR), <10 <sup>-6</sup> * /event/pixel for IB and OB		<<<10 <sup>-6</sup> /event/pixel
Total Ionizing Dose	270 krad 2.7 Mrad*	10 krad, 100 krad*	Up to 500 krad
Non-Ionizing Energy Loss (1 MeV n <sub>eq</sub> /cm <sup>2</sup> )	1.7 x 10 <sup>12</sup> (TDR), 1.7 x 10 <sup>13</sup> *	1.7 x 10 <sup>11</sup> (TDR), 1.7 x 10 <sup>12</sup> *	Up to 1.7 x 10 <sup>13</sup>

radiation load integrated over the approved program (~ 6 years of operation)

\*revised numbers with respect to ALICE TDR (factor 10)

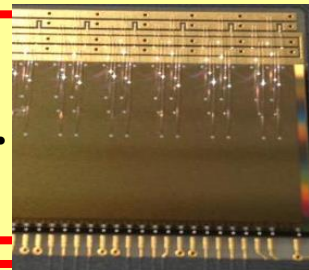
# New pixel sensors for ALICE experiment: ALICE Pixel detectors (ALPIDE family)



**2012** **Explorer** **Explorer-1,2** → **Two submatrices: 90x90 array of 20 x 20µm pixels and 60x60 array of 30x30µm pixels. Each sub-matrix is divided into 9 sectors with one variant of collection electrode(analogue readout). Investigations: pixel geometry, starting material, sensitivity to radiation.**

**2013** **pALPIDEss** → **Matrix with 64 columns x 512 rows of 22µm x 22µm pixels. (in-pixel discrimination and buffering). Study priority encoder and the front-end electronics**

**May-2014** **pALPIDE-1** → **Full-scale prototype to study system effects: 1024 columns x 512 rows of 28µm x 28µm pixels. 4 sectors with different pixels.**



**May-2015** **pALPIDE-2** → **4 sectors with different pixels. Optimization of several circuit blocks. Allows integration into ITS modules**

**Oct-2015** **pALPIDE-3** → **8 sectors with different pixels. Final interfaces, more features including 1.2 Gbit/s output serial link.**

**Jul - 2016** → **ALPIDE – Final Version**

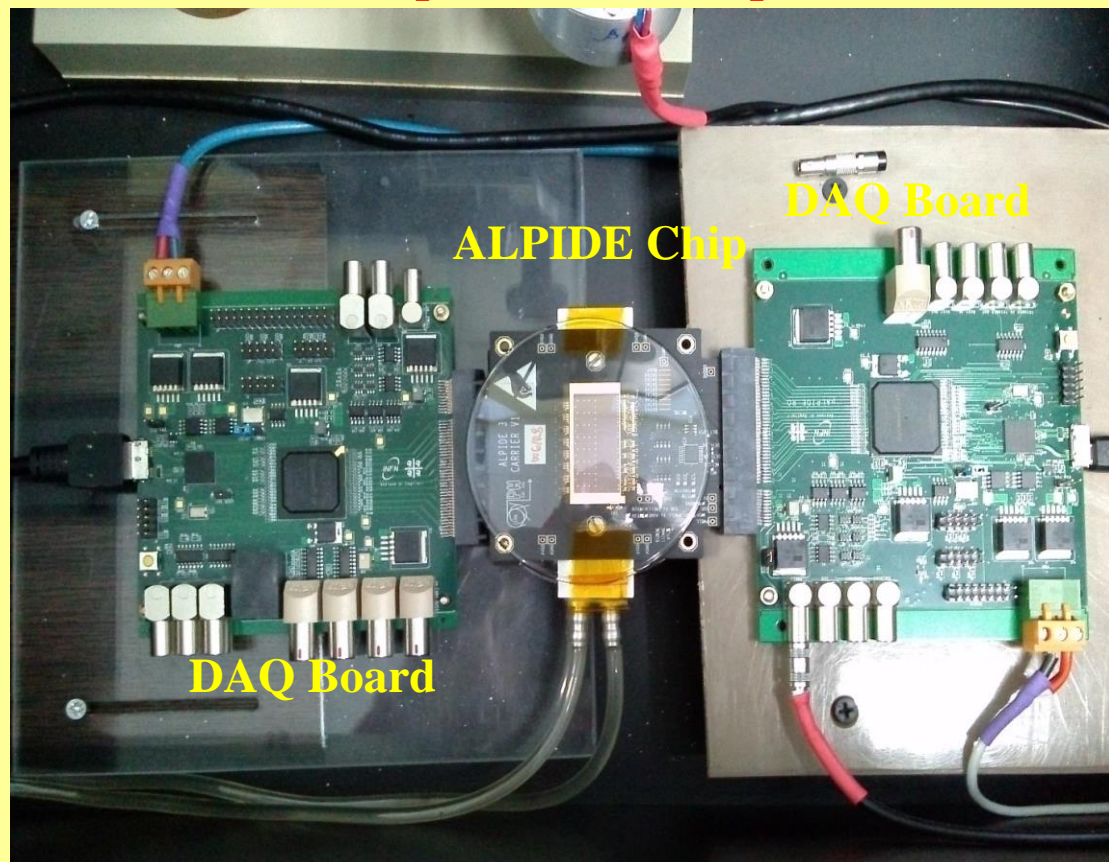
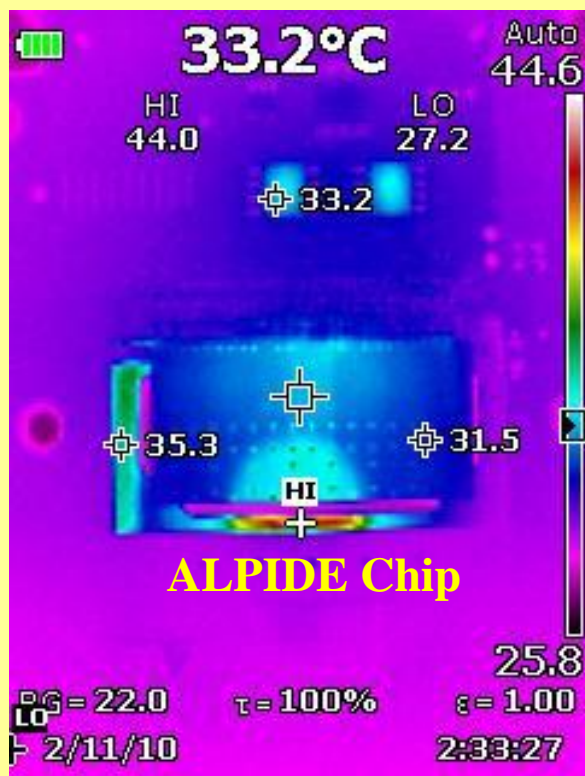


# Study of the characteristics of ALICE ITS pixel detectors



1. Two different chip types (telescope geometry) with own DAQ boards were installed.
2. Detector Power supply(current control).
3. Dark box with electrical earthing inside. Temperature control inside the box.
4. Radioactive source ( $\gamma\beta$ ) positioning system.
5. The water cooling(heating) system was implemented.
6. Thermo-camera for detector heating investigations.

## Experimental set-up: I



All generations of ALPIDE chip: pALPIDE-1,2,3 and final version were studied



## Characterization and tests

### 1. Electrical tests:

- a) **On-chip Digital-Analogue Converter Test.** The output of the on-chip DACs is connected to monitoring pins of the detector and measured by ADCs on the DAQ board.
- b) **Digital Scan.** Scan generates a digital pulse in a number of pixels and reads the hits out. The number of injections per pixel and the group of pixels can be set.
- c) **Analogue Scan.** A programmable charge is injected into the preamplifier. The values of the injected charge, as well as the number of injections per pixel and the groups of pixels can be set.
- d) **Threshold Scan.** Scan performs analogue injections, looping over the charge ranging from 7 to 350 electrons. The values of the threshold can be set.

### 2. Noise characteristics of the sensor and its temperature dependence were studied

The scan gives a selectable number of random triggers and returns the number of hits. The values of threshold current (ITHR) and threshold voltage (VCASN) and also chip temperature can be set.

### 3. Studies with a variety of gamma and beta sources were carried out

The scan gives the number of hits using the selectable number of random triggers. Radioactive source measurements are needed to study the uniformity of hit-maps and to evaluate cluster shape and size. The noise mask is prepared before the scan and can then be used in measurements.

**All results for pALPIDE-3 see in Back up slides**

# Study of the characteristics of ALICE ITS pixel detectors

The performance of irradiated sensors at different temperatures, including cryogenic temperatures



## Detectors ALPIDE (final version)

Detectors were irradiated by:

X-rays (from X-ray machine)



Chip W8R22 – 60 krad (low dose )

Chip W7R12 – 300 krad (high dose)



Before irradiation Chip W7R12 was measured at lab.

All measurements were done at back bias voltage  $V_{bb} = -3V$

# Study of the characteristics of ALICE ITS pixel detectors

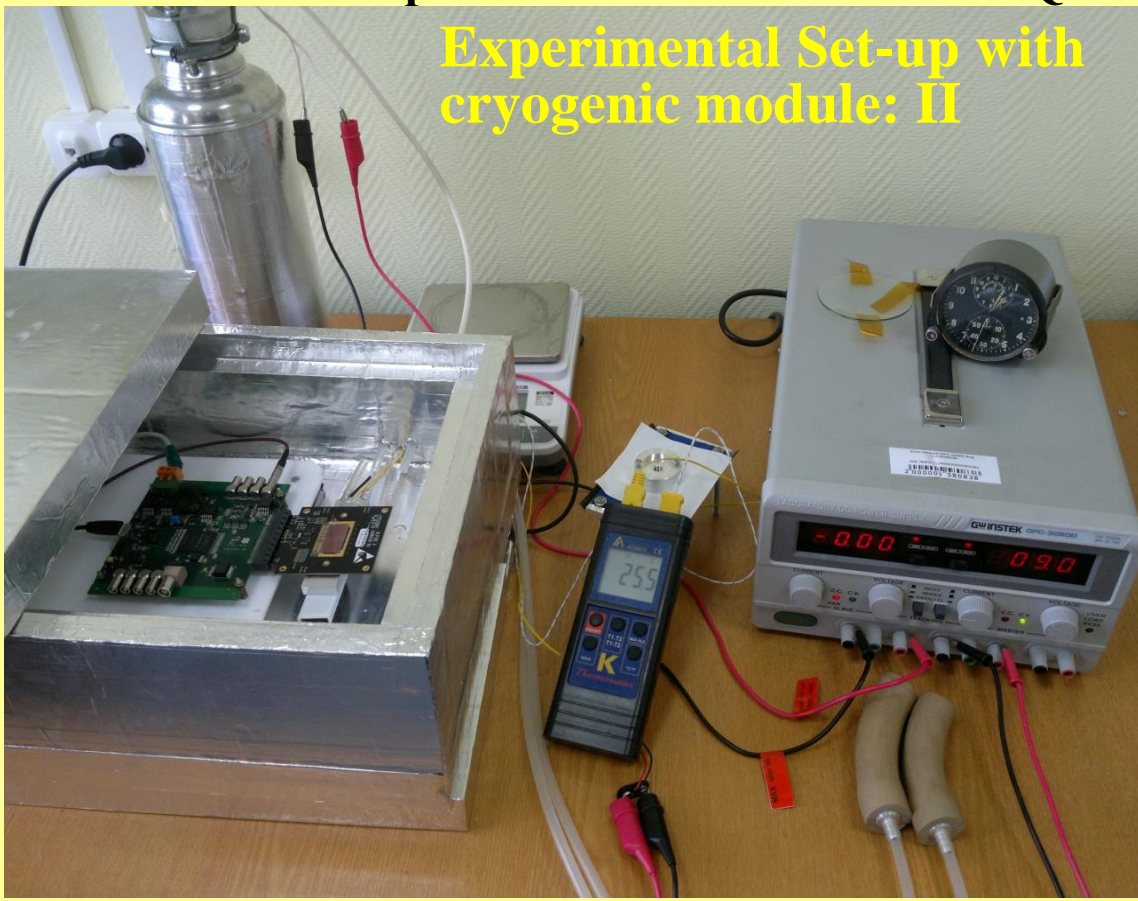


1. Cryo-box.
2. Irradiated ALPIDE chip + DAQ board.
3. Chip was mounted on cooled platform.
4. Three thermocouples (1 copper-constantan, 2 chromel-alumel) mounted on cooled platform. Each thermocouple has own controller and DAQ

Experimental Set-up with cryogenic module: II



5. Dewar vessel with heater system.
6. Source holder.
7. Analytical balance







## Second Experimental Set-up with cryogenic module

Two different modes of the cooling process:

1. Cooling and heating with the chiller (alcohol-containing mixture), range: from **+65 °C to -20 °C**.

To protect a chip against frost the nitrogen was supplied in a cryo-box.

2. Cooling with liquid nitrogen through evaporation.

The liquid nitrogen was heated by nichrome heater mounted inside the Dewar vessel. Cold gas is then flowing through platform (inside platform).

We can regulate the nitrogen flow, by powering the nichrome heater (different currents up to 6 A).

We can also control the volume of the liquid nitrogen by weighing the Dewar vessel.

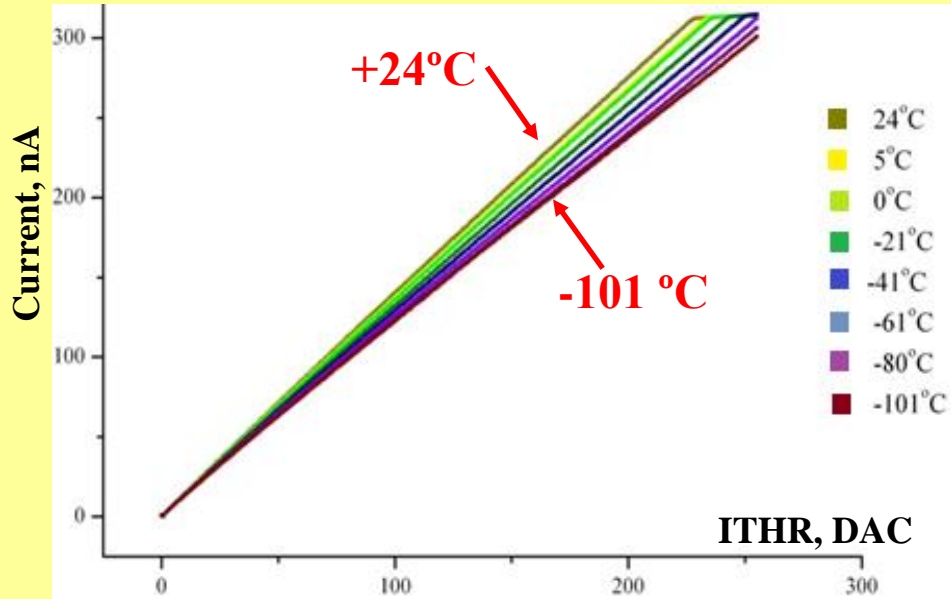
Temperature control:

a) 3 thermocouples

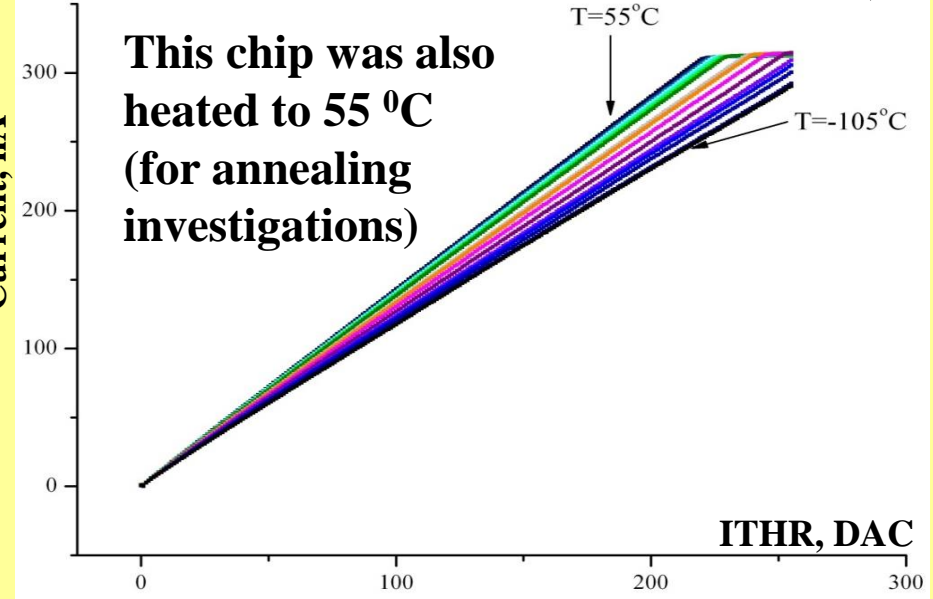
b) on-chip temperature sensor. This sensor works only up to **-80 °C**.

**A temperature of -115 °C has been reached**

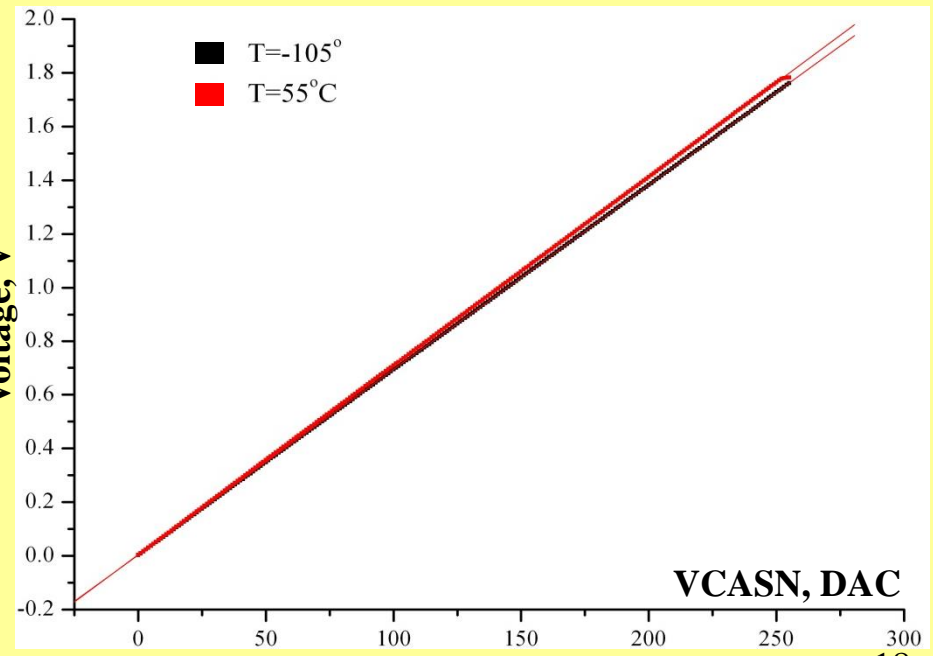
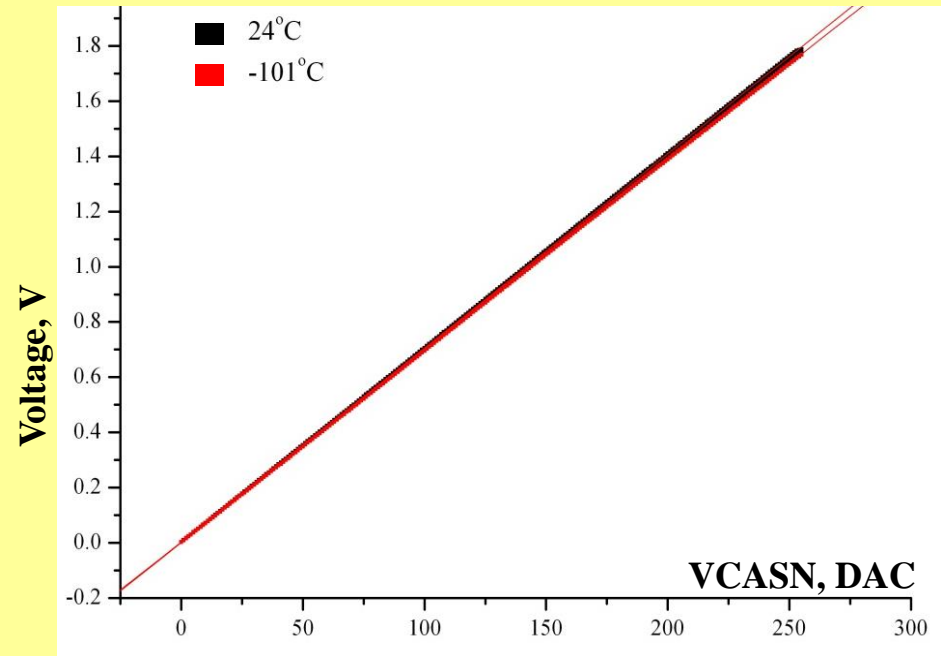
# Study of the characteristics of ALICE ITS pixel detectors



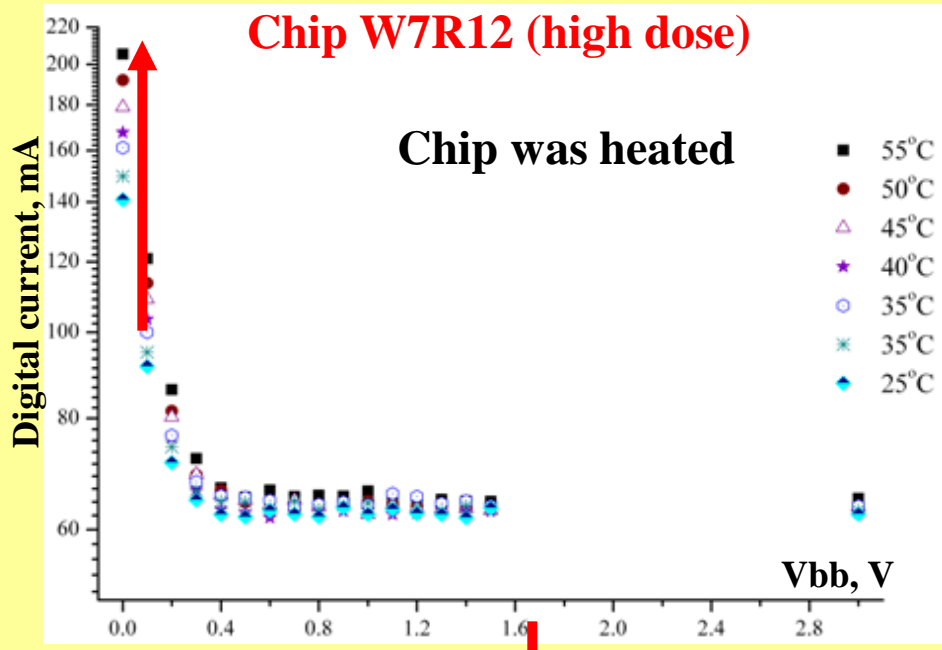
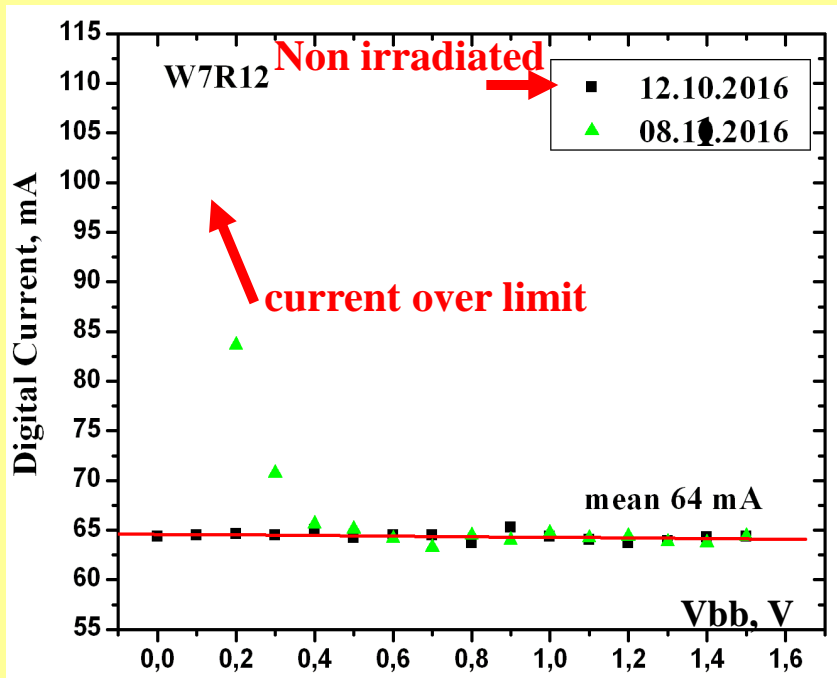
**DAC Scan Chip W8R22 (low dose)**



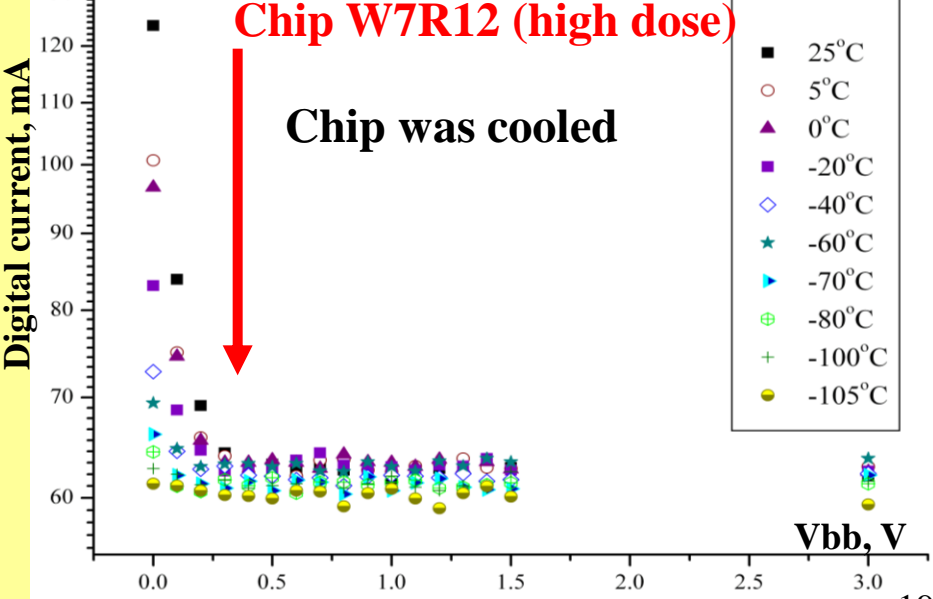
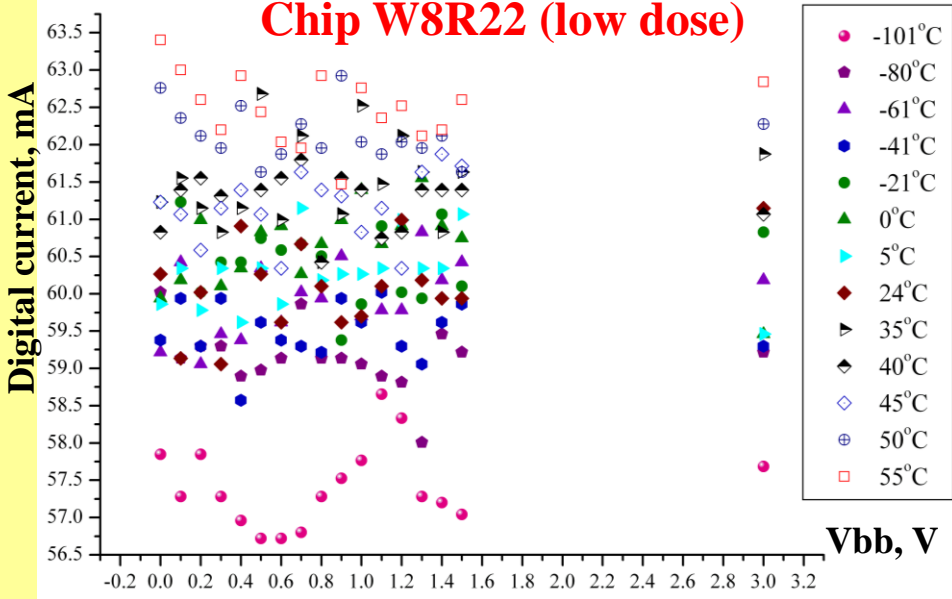
**DAC Scan Chip W7R12 (high dose)**



# Study of the characteristics of full-scale Pixel Detector prototypes



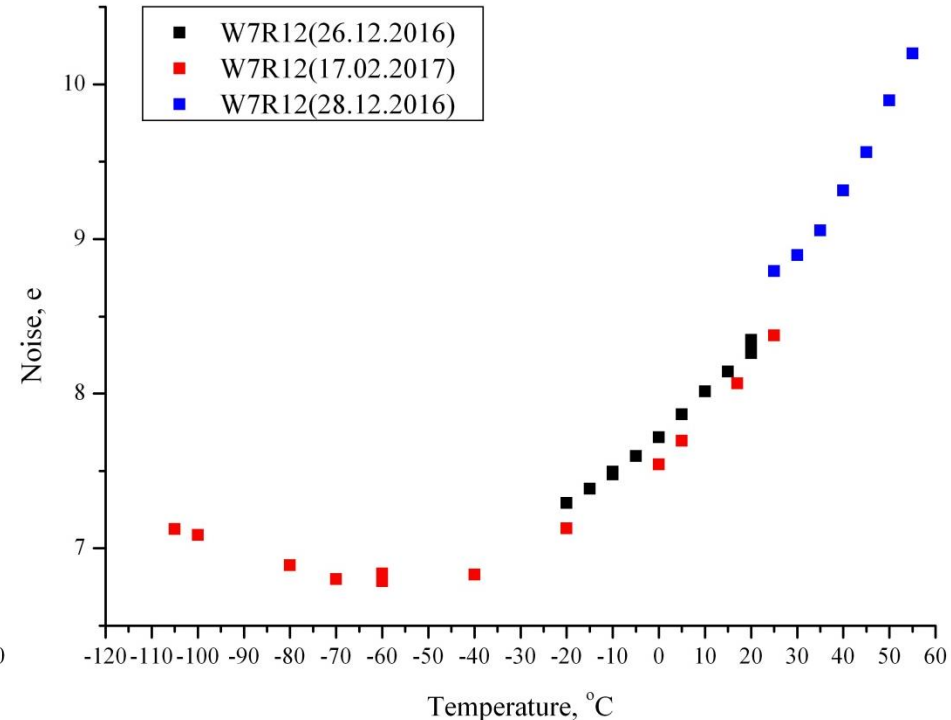
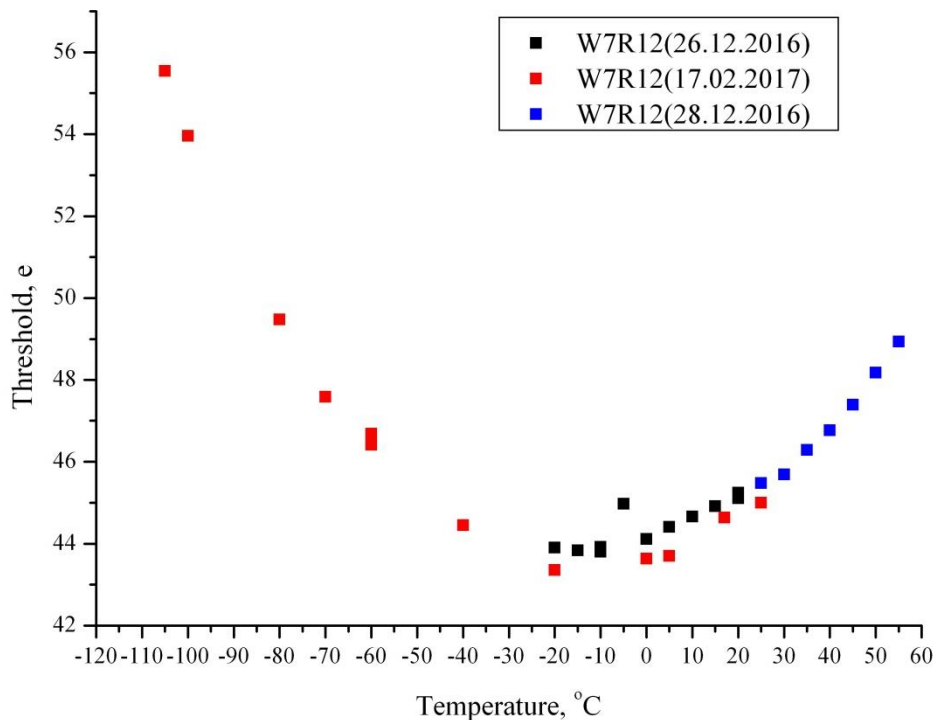
## Digital Currents



## Threshold Scan

### Results for high dose irradiated chip

### Chip W7R12 (high dose)



Before irradiation the threshold was ~ 85 e,  
after irradiation (300 krad)  
the threshold was ~ 45-50 e

Before irradiation the noise was ~ 6 e,  
after irradiation (300 krad)  
the noise was ~ 14 e

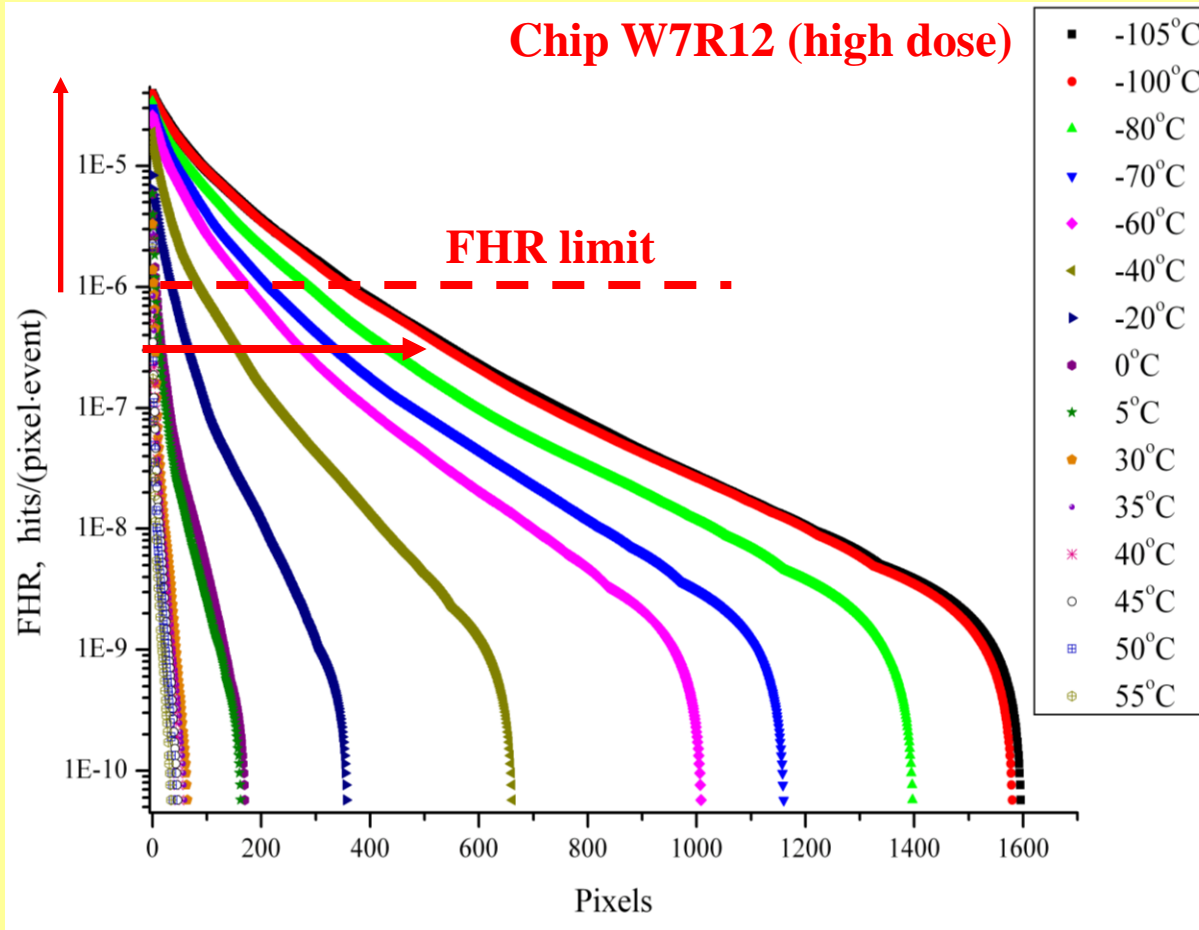
The threshold goes up both with increasing temperature and with lowering temperature, but initial value (before irradiation) of the threshold is not reached.

# Study of the characteristics of ALICE ITS pixel detectors



Results for high dose irradiated chip

Noise Occupancy Scan



1. The number of pixels to be masked to achieve certain **fake-hit rate** **increases** with the lowering of temperature.

2. FHR also increases with temperature decreasing

3. For low dose irradiated chip and non irradiated chip fake-hit rate **DID NOT** change over the full temperature range: **from -115 to +30 °C**

# Study of the characteristics of ALICE ITS pixel detectors



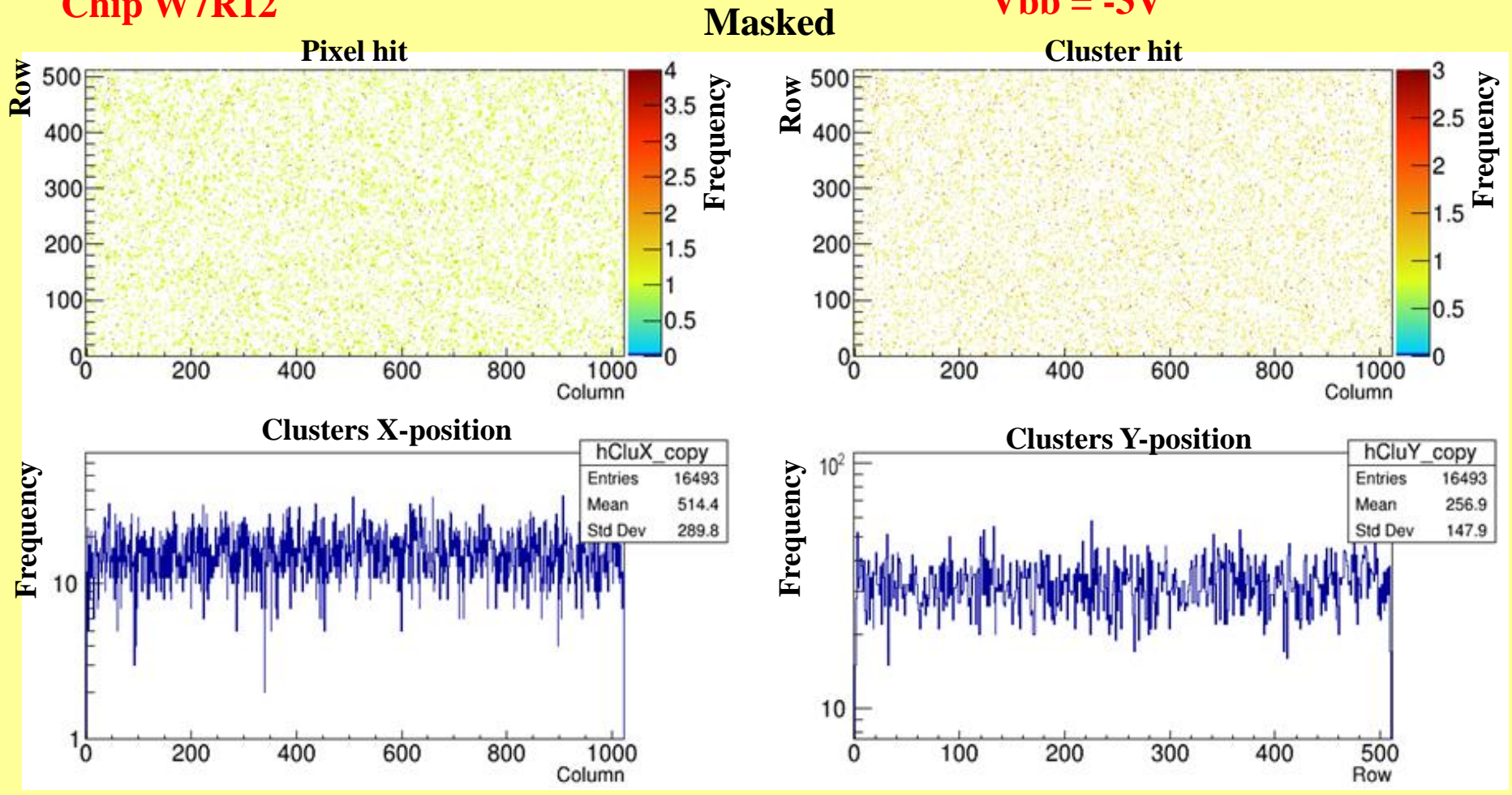
## Source test + Cluster analysis

Results for high dose irradiated chip

Chip W7R12

Triggers: 200000

V<sub>bb</sub> = -3V



Source:  $^{133}\text{Ba}$ , chip temperature: -115 °C

↓  
Gamma: 5.64 keV

# Study of the characteristics of ALICE ITS pixel detectors



## Source test + Cluster analysis

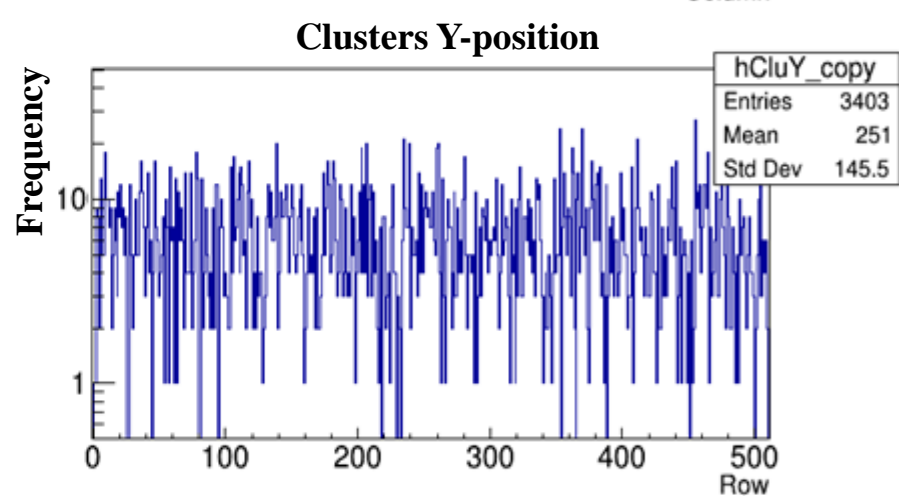
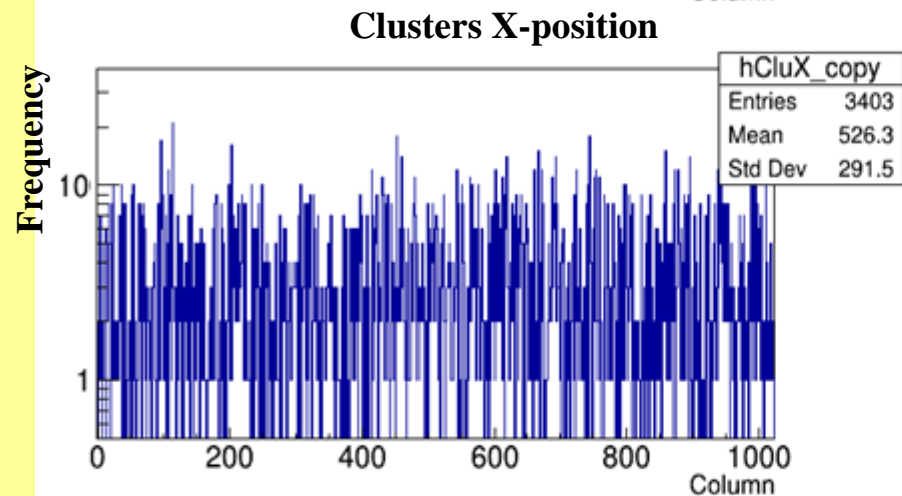
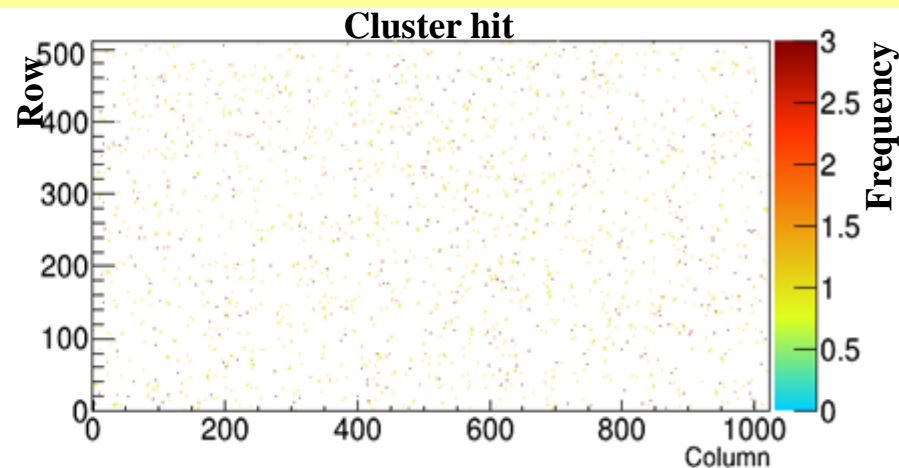
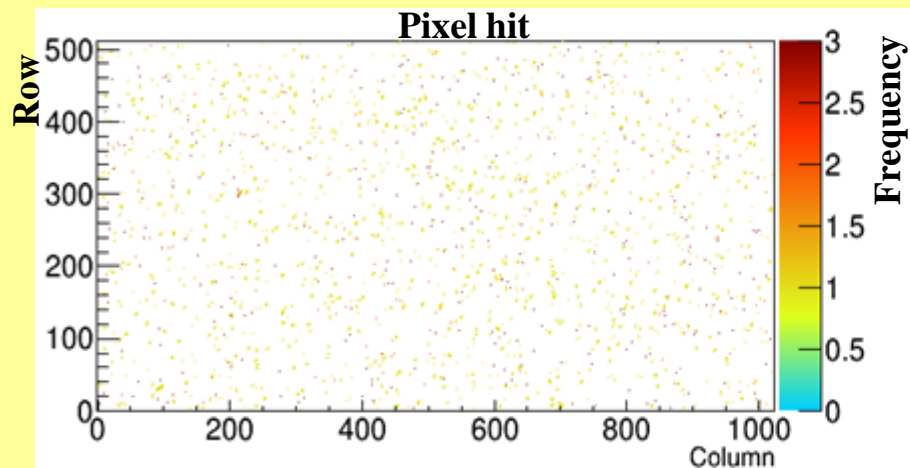
Chip W7R12

Triggers – 2000000

Vbb = -3V

Results for high dose irradiated chip

Masked

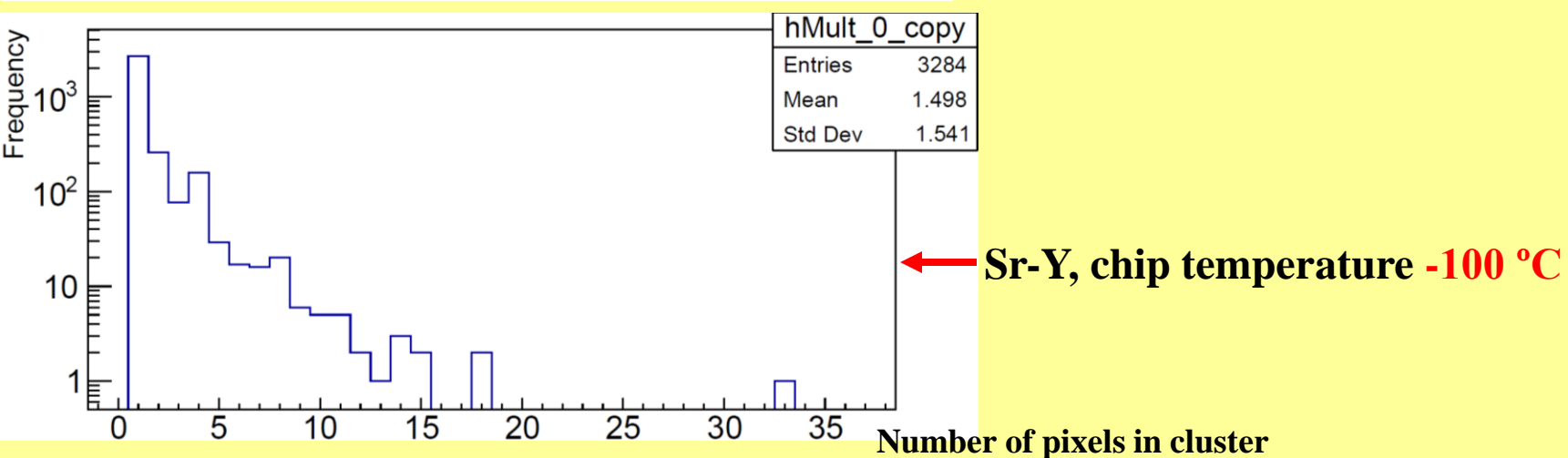
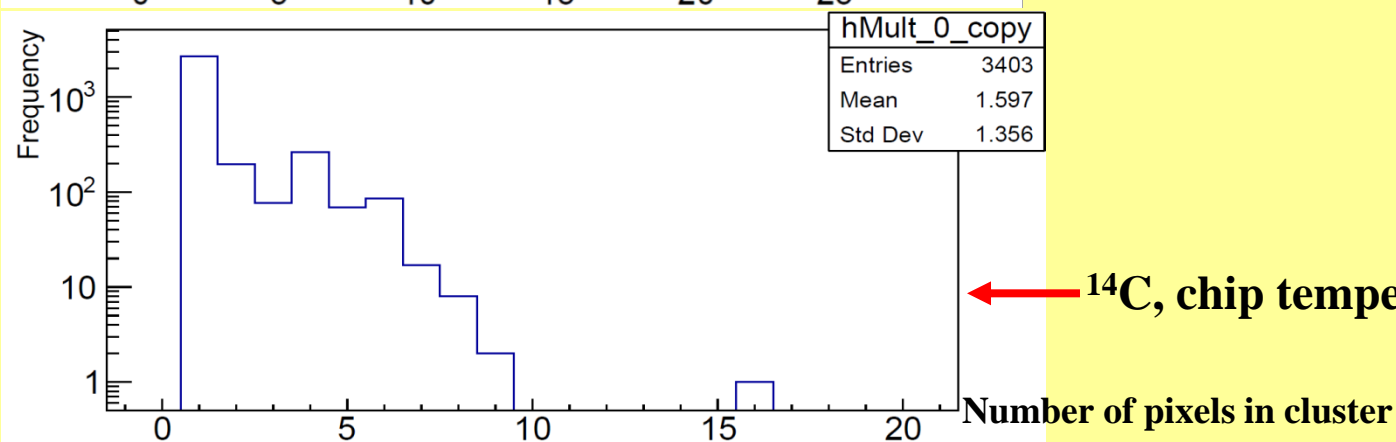
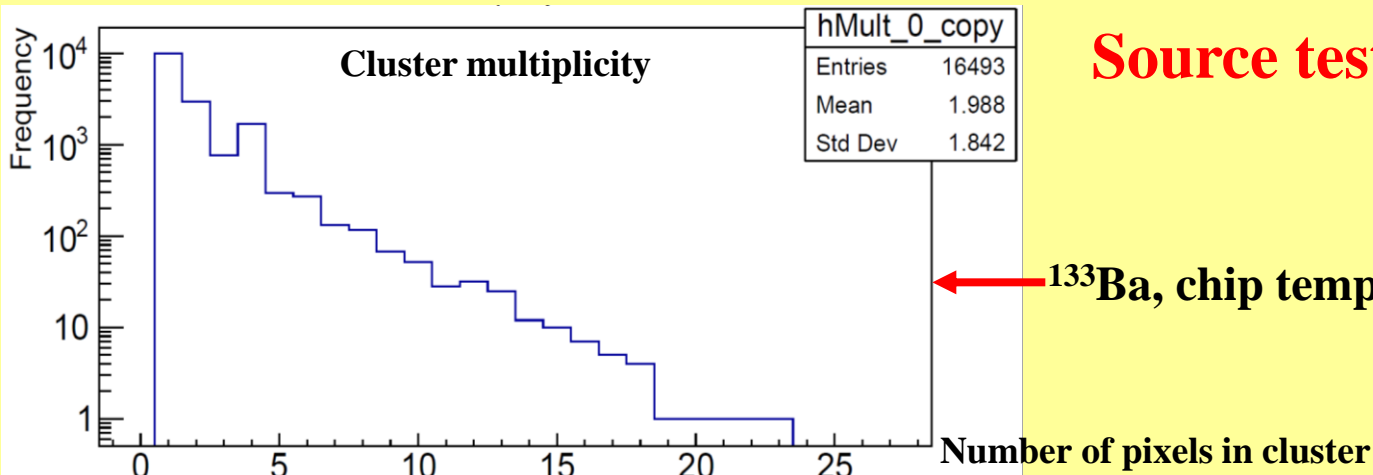


Source:  $^{14}\text{C}$ , chip temperature:  $-100\text{ }^\circ\text{C}$   
beta: 156 keV

for another beta source Sr-Y see Back-up

# Source test + Cluster analysis

Chip W7R12 (high dose)

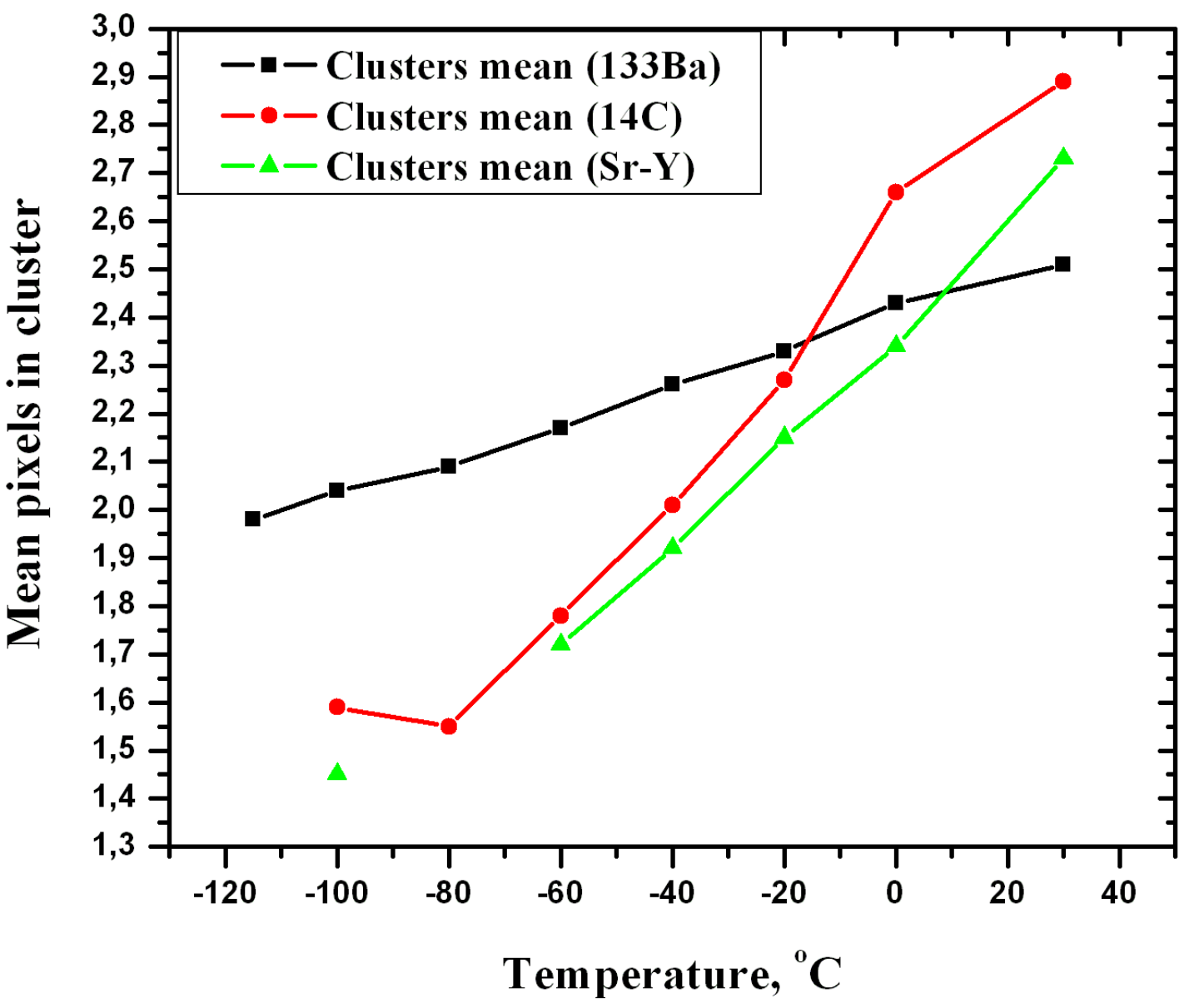






## Source test + Cluster analysis

Chip W7R12 (high dose)

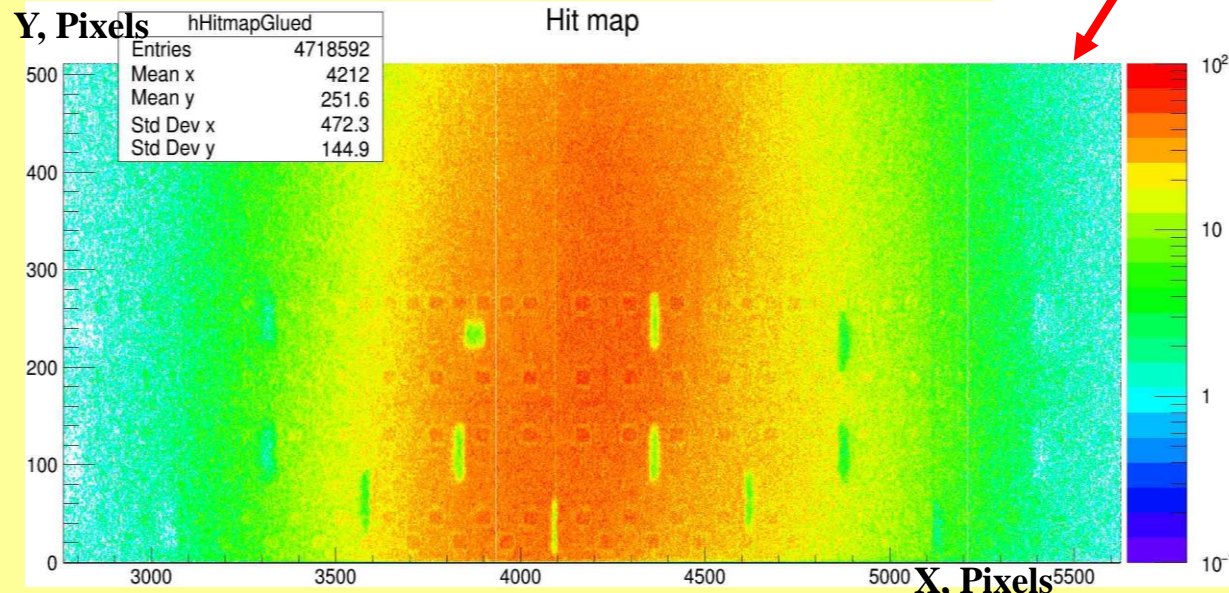
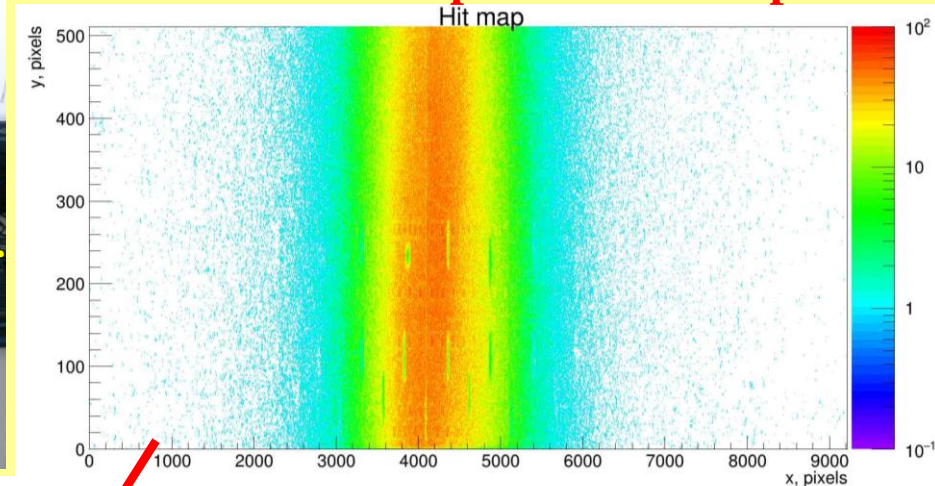
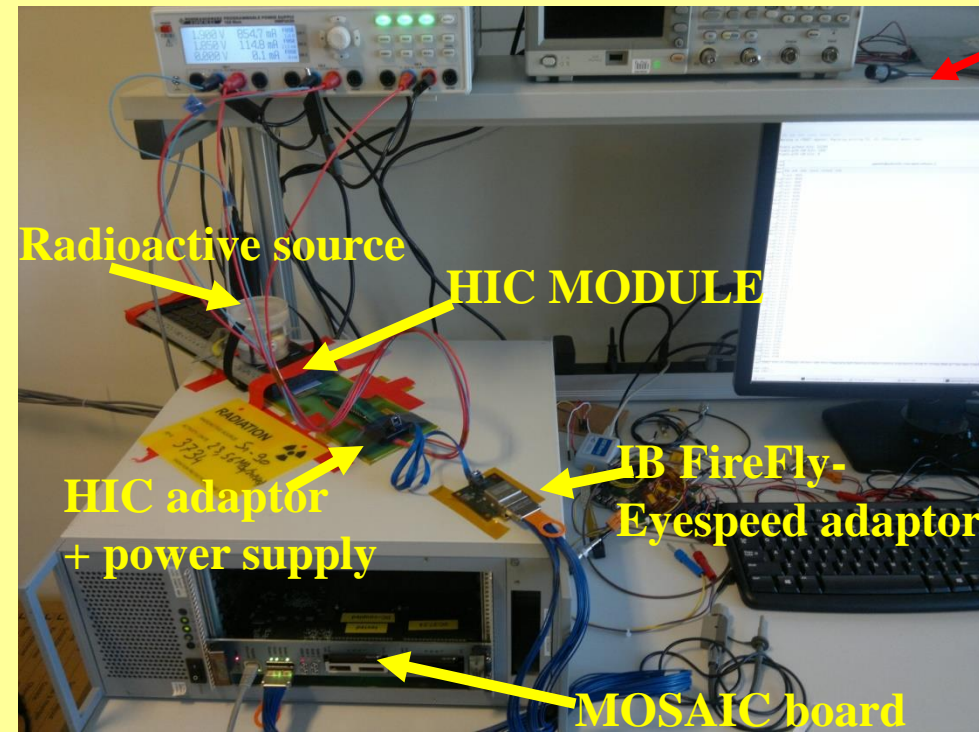


# Study of the characteristics of ALICE ITS pixel detectors

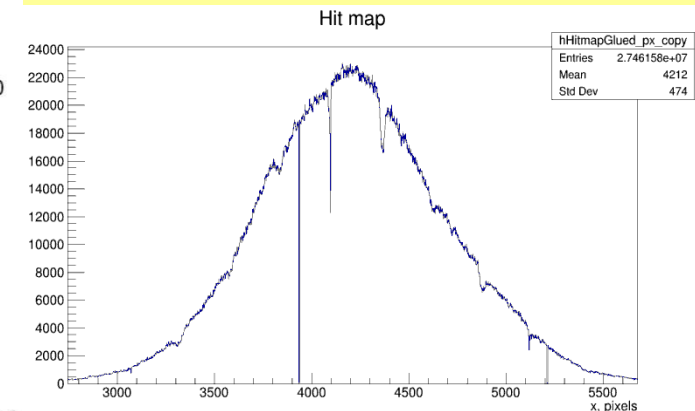
**HIC – Hybrid Integer Circuit consists of 9 ALPIDE chips**

**MOSAIC - MODular System for Acquisition Interface and Control**

**Beam spot between chip 3-4**



**Hit projection on X-axis: chip 3-4**

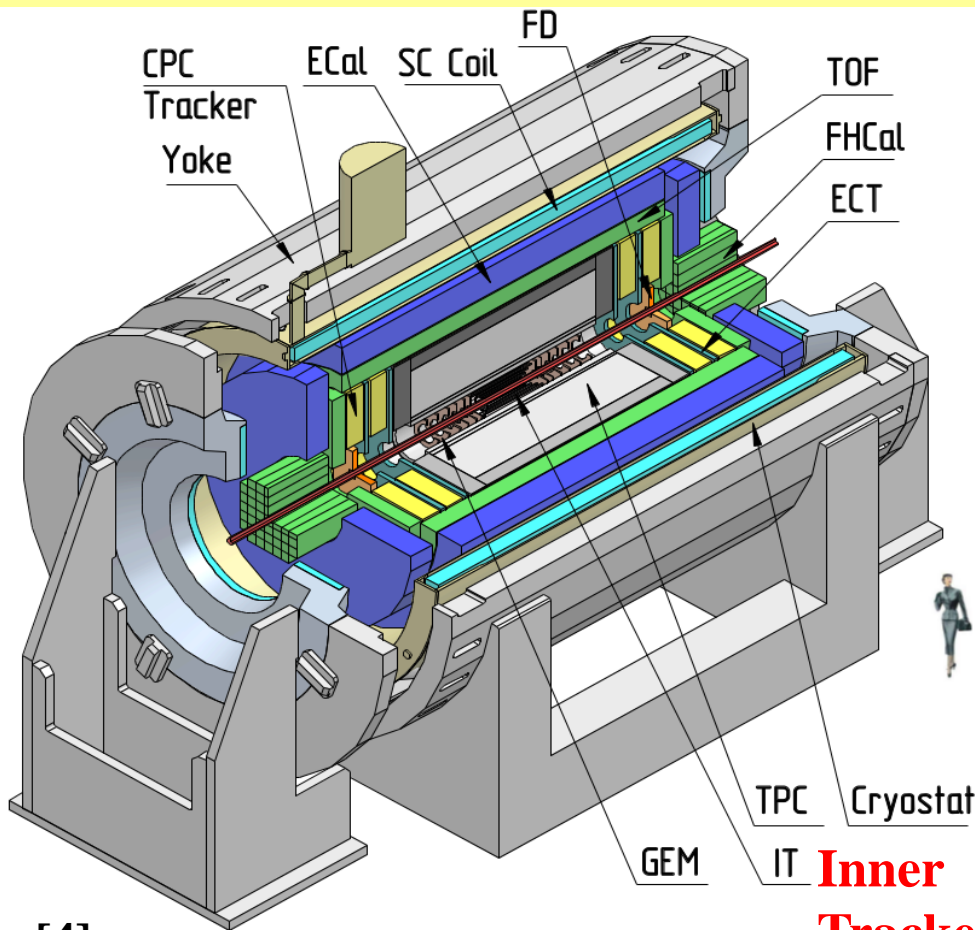


## NICA MPD

High vertex resolution

Fast readout (for Au-Au collisions the luminosity will be  $10^{27} \text{ cm}^{-2}\text{s}^{-1}$ )

Low material budget



[4] **Inner Tracker**

One of the possible solutions:

1. Use ALICE MAPS – ALPIDE

2. Use carbon ultra-lightweight support

and cooling structures developed for the upgrade of ALICE at the LHC

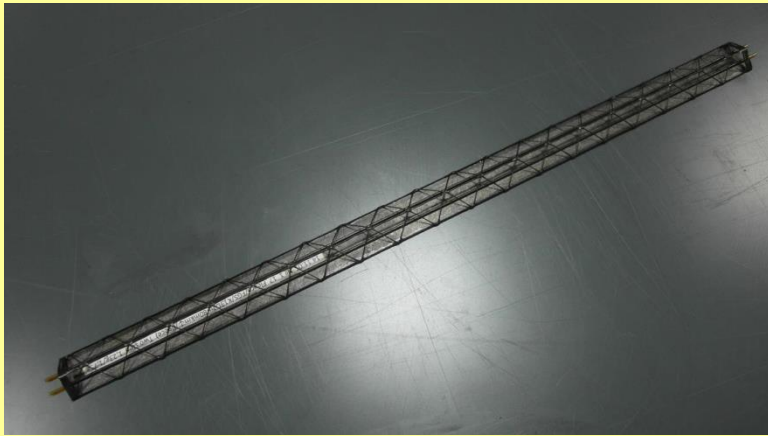
Parameter	ALPIDE Performance
Silicon thickness	50 $\mu\text{m}$
Chip dimension	15 mm x 30 mm
Spatial resolution	5 $\mu\text{m}$
Power density	40 mW/cm <sup>2</sup>
Max. integration time	10 $\mu\text{s}$
Detection efficiency	>99%
Fake-hit rate	$\lll 10^{-6}$ /event/pixel
Total Ionizing Dose	Up to 500 krad

# Pixel detectors for NICA experiments

## NICA MPD



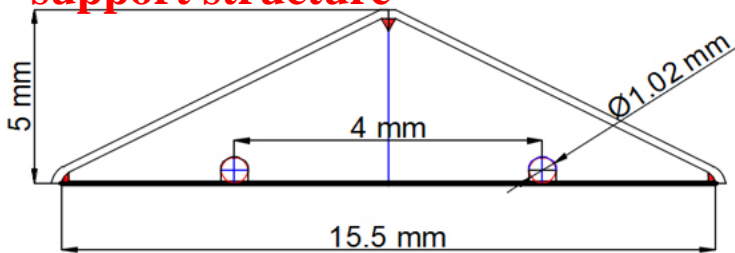
## 2. Use carbon ultra-lightweight support and cooling structures developed for the upgrade of ALICE at the LHC



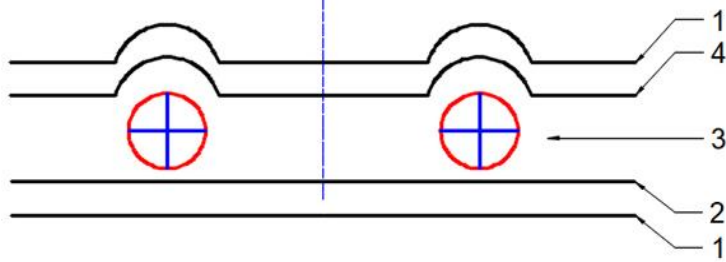
But for MPD Inner Tracker detailed simulations of the geometry and requirements to all detector modules should be done!



### ALICE Inner barrel carbon support structure [5]

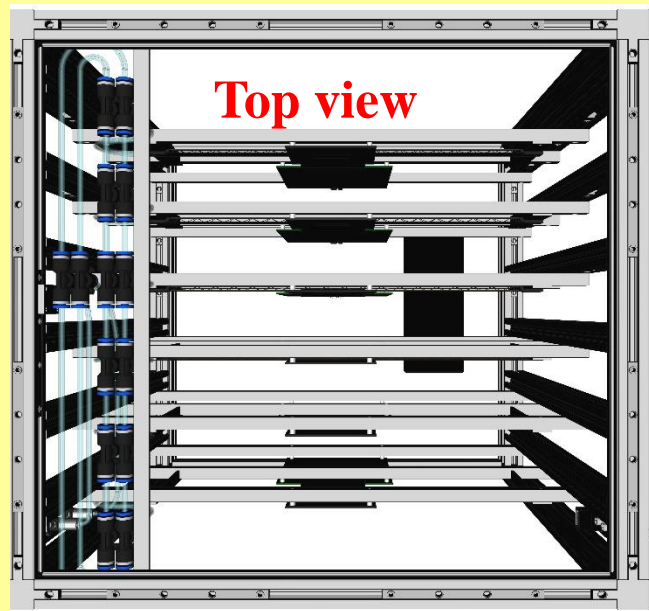
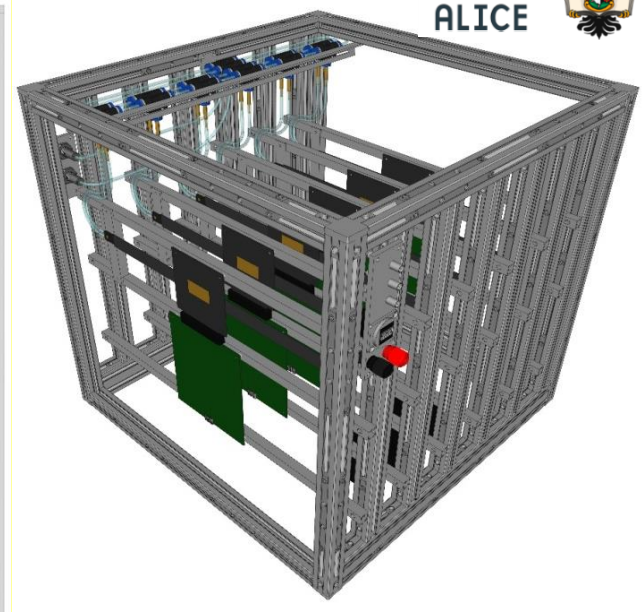
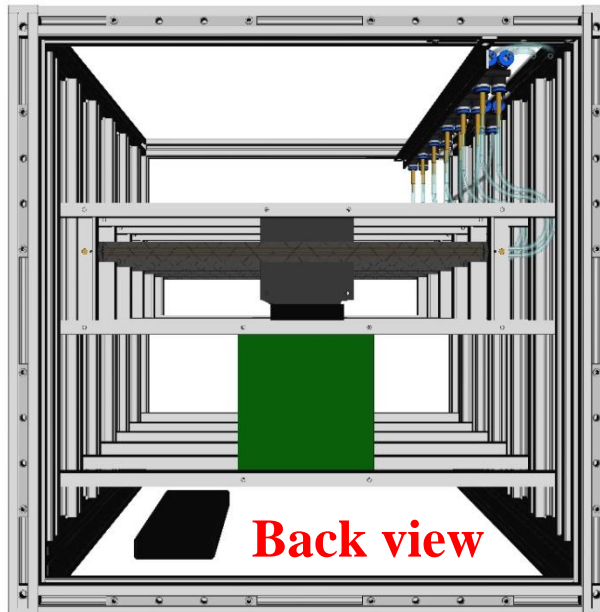
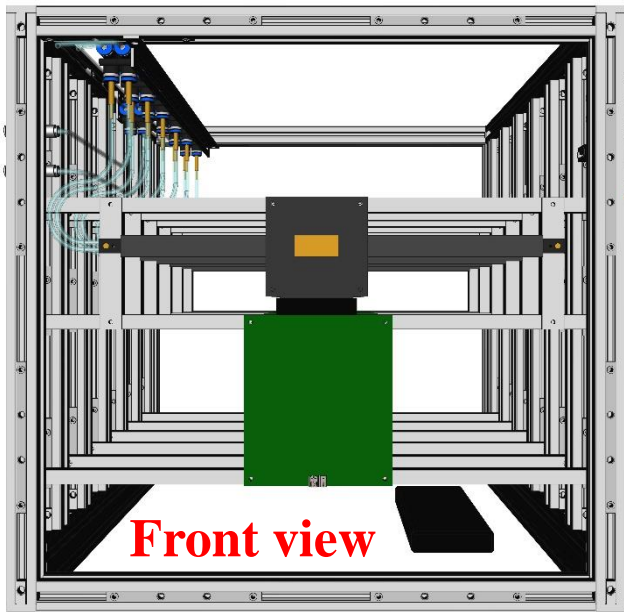


Layering scheme

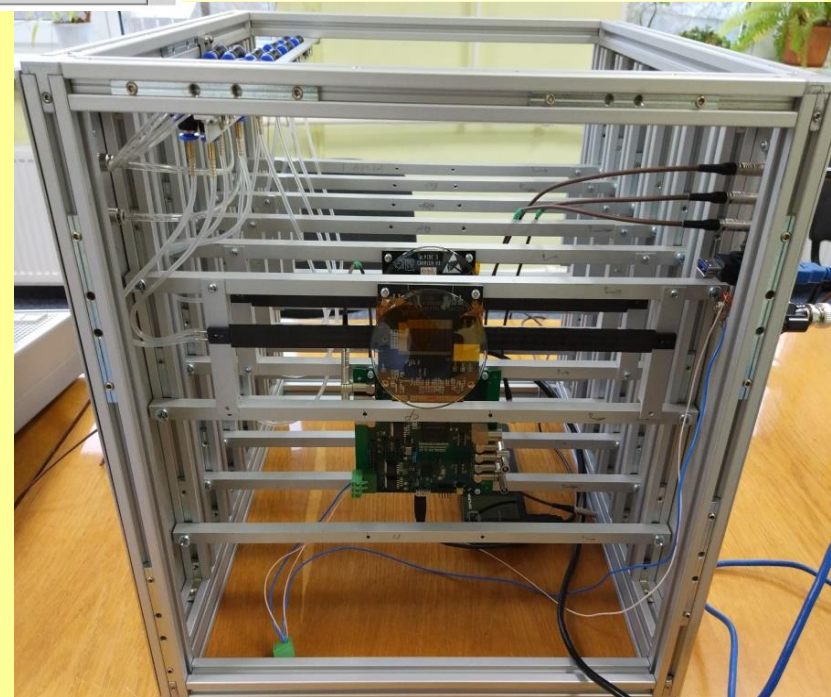


The same for NICA SPD experiment

1. Carbon-fiber fleece 20  $\mu\text{m}$  (down and top);
2. Carbon-fiber plate 18 mm wide, 70  $\mu\text{m}$ ;
3. Round polyimide tubes, diameter 1.02 mm;
4. Carbon paper, 30  $\mu\text{m}$ .



Experimental set-up  
for the ALPIDE  
MAPS  
characterization for  
the NICA MPD  
Inner Tracker: VT-1



# Summary



- 1. The overview of ALICE ITS upgrade in detector context. New MAPS detectors.**
- 2. Two test stations (based on the chip, DAQ board and software, cryogenic module) were constructed within the ITS upgrade project for the characterization and tests of the ALPIDE detectors.**
- 3. To investigate the main characteristics of the pixels, electrical tests and comprehensive studies with a variety of gamma and beta sources were carried out.**
- 4. The studies of irradiated sensors at different temperatures, including cryogenic temperatures, were also carried out.**
- 5. Ideas of how the ALICE technology could be applied for MPD or SPD experiments**

**Experimental set-up for the future characterization of ALPIDE MAPS for the NICA MPD Inner Tracker: VT-1 has been developed, constructed and tested.**

## Next plans

- 1. Modernization of VT-1 for the beam measurements.**
- 2. Studies of the ALPIDE characteristics using electron beams and NUCLOTRON beams in JINR**
- 3. Investigation of characteristics of ALPIDE (Final Version of the detector) and Hybrid Integrated Circuit (with 9 ALPIDE chips).**

# Literature



- 1. ALICE: <http://cdsweb.cern.ch/collection/ALICE%20Photos?ln=ru>**
- 2. L.Musa, ECFA High Luminosity LHC Experiments Workshop, Aix-Les Bains, 3-6 October 2016 and F. Reidt, PIXEL2016 , 05.09.2016 - 09.09.2016.**
- 3. The ALICE Collaboration. “Technical Design Report for the Upgrade of the ALICE Inner Tracking System”. In: J. Phys. G41 (2014), p. 087002.**
- 4. V.D. Kekelidze, on behalf of the NICA Collaboration, JINST 12 C06012, 2017.**
- 5. V.I. Zhrebchevsky, I.G. Altsybeev, G.A. Feofilov, A. Francescon, C. Gargiulo, S.N. Igolkin et al., JINST 13 T08003, 2018.**



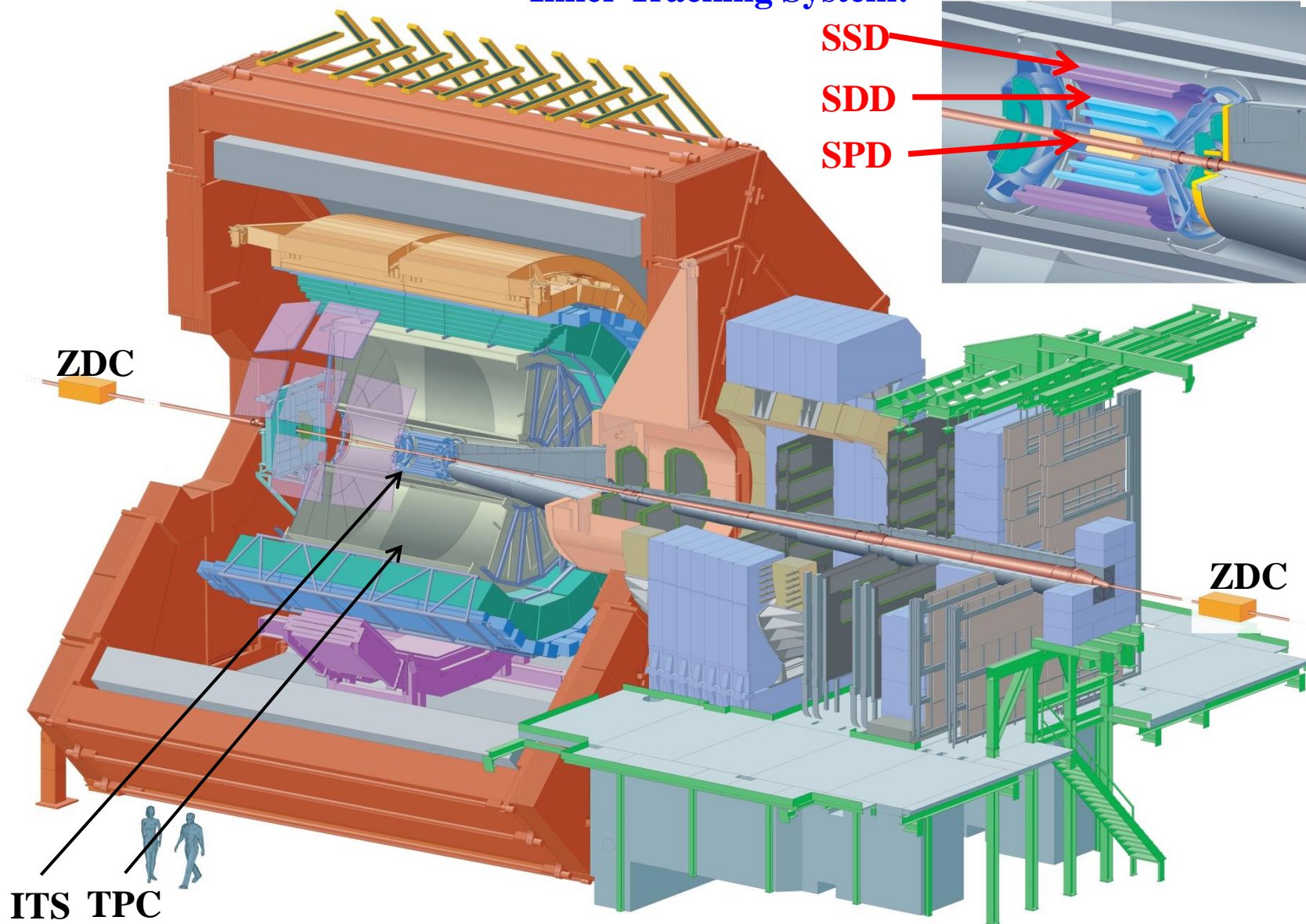
# BACK-UP SLIDES



# ALICE Inner Tracking System (current status)



## Inner Tracking System:



Current ALICE set-up with its main detectors [1]



## Physics

**Heavy- flavour measurements with largely improved tracking and read-out rate capabilities**

**Two main open questions concerning heavy-flavour interactions with the QGP medium are:**

- 1. Thermalisation and hadronisation of heavy quarks in the medium. Measuring the heavy-flavour baryon/meson ratio, the strange/non-strange ratio for charm, the azimuthal anisotropy for charm and beauty mesons, and the possible in-medium thermal production of charm quarks**
- 2. Heavy-quark in-medium energy loss and its mass dependence.**

**Also detailed measurement of low-mass dielectrons (low material budget and the improved tracking precision and efficiency of the new ITS):**

**Thermal radiation from the QGP, via real and virtual photons detected as dielectrons**

**Also production measurement of hypernuclear states**



## Physics

Improve primary vertex reconstruction,  
momentum and impact parameter  
Resolution

### Resolution

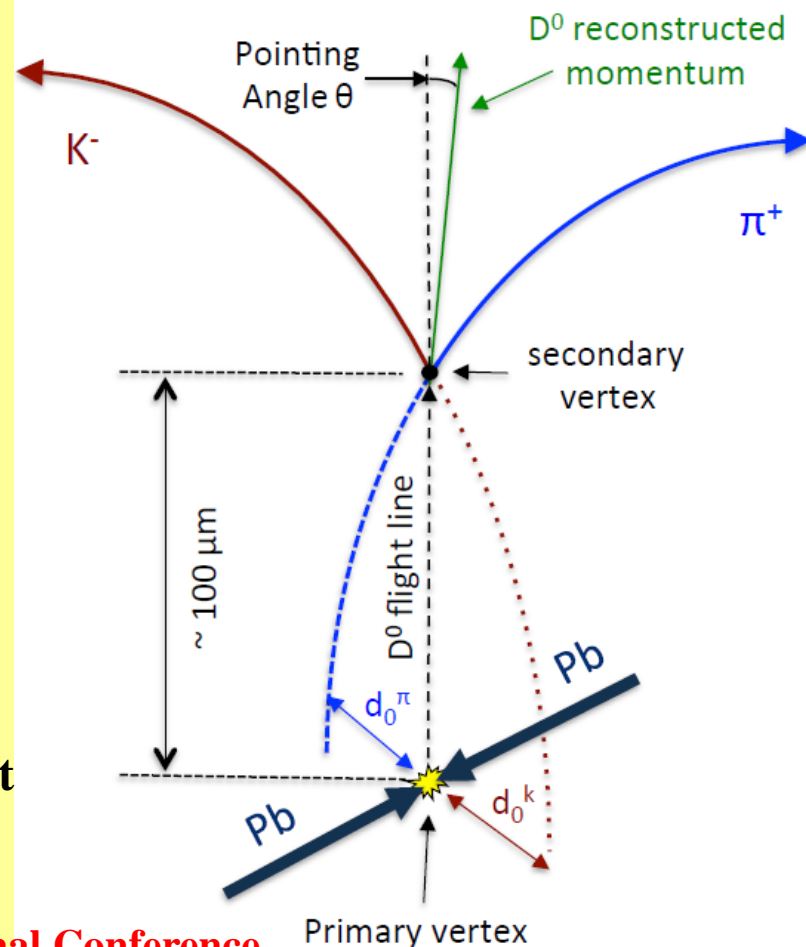
Reconstruction of secondary vertices from c and b  
decays with high resolution

Particle	Decay Channel	$c \cdot \tau$ ( $\mu\text{m}$ )
$\Lambda_c^+$	$pK^-\pi^+$	60

Current ITS Impact Parameter Resolution  $\sim 70 \mu\text{m}$  at  
 $p_t=1\text{GeV}/c$

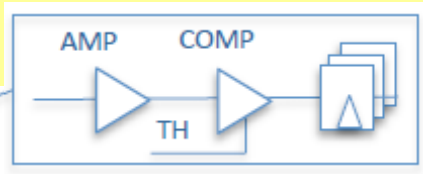
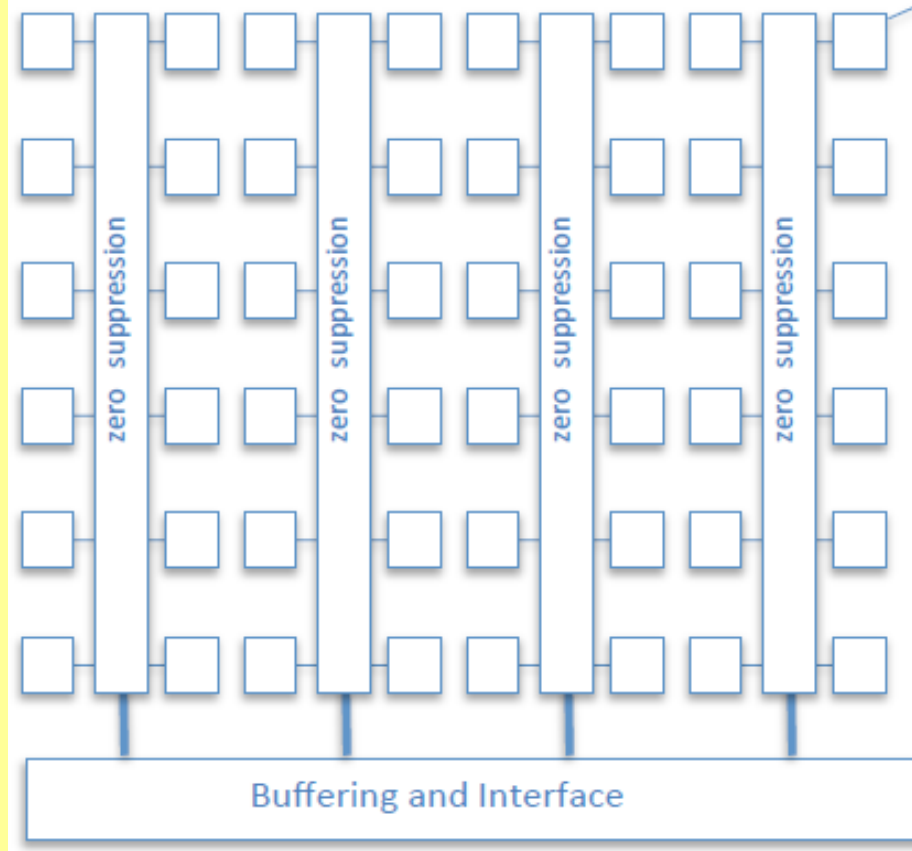
## Secondary vertex determination

Example:  $D^0$  meson





## ALPIDE chip architecture



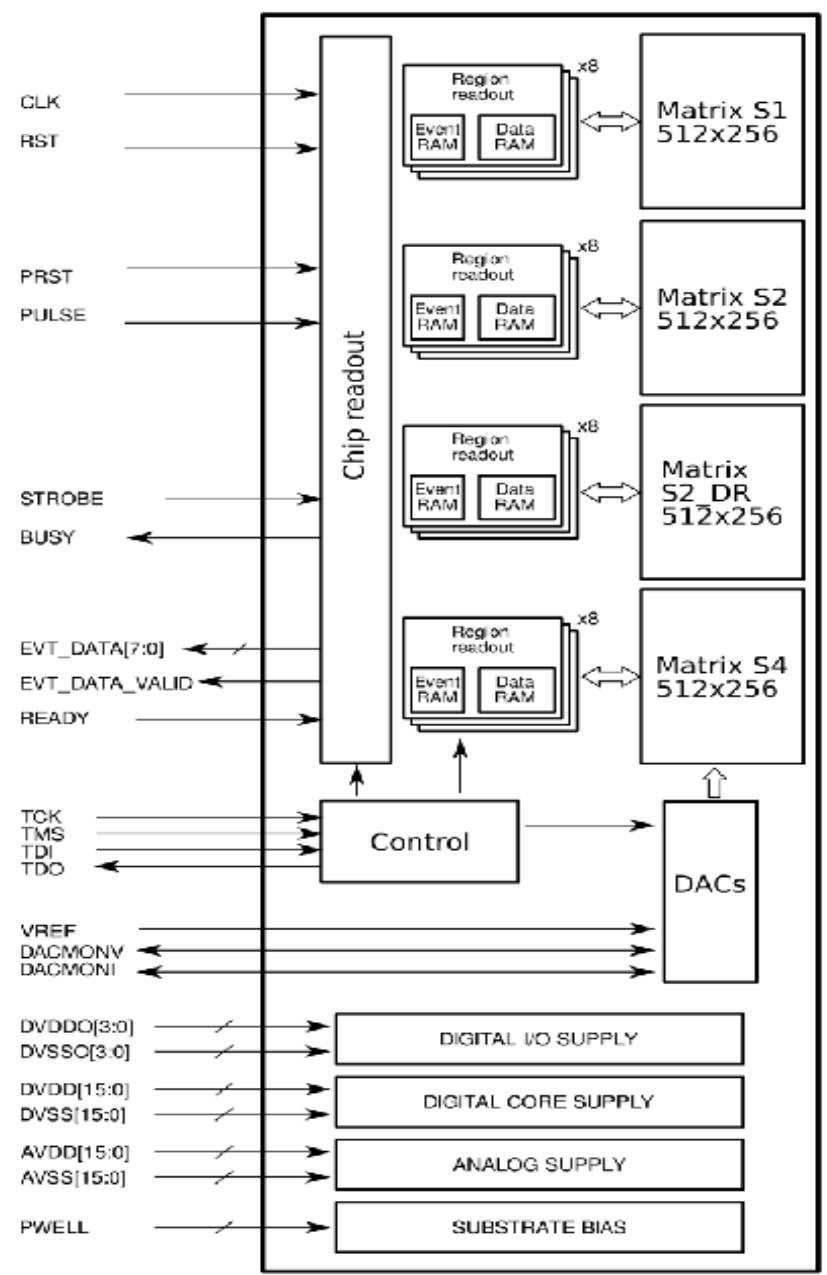
- In-pixel amplification
- In-pixel discrimination
- In-pixel (multi-) hit buffer

### Advantages

1. Analog signal is no longer driven over the column lines → reduce power consumption and increase readout speed.
2. The realization of in-pixel discriminators: opportunity of readout, in which the digital outputs of the pixels are scanned by an encoder circuit that directly produces the address of hit pixels as output.
3. The circuit works in a way that the pixel hit register is reset after the read operation and the circuit will move on to the next hit pixel to encode its address. The procedure is iterated until the full pixel matrix is read out.

The zerosuppression is performed within the matrix. Address-Encoder Reset-Decoder circuit is employed. It can either be controlled by an external trigger signal or operated in continuous acquisition mode.

# New pixel sensors for ALICE experiment: ALICE Pixel detectors (ALPIDE family)



## A general block diagram of pALPIDE-1,2

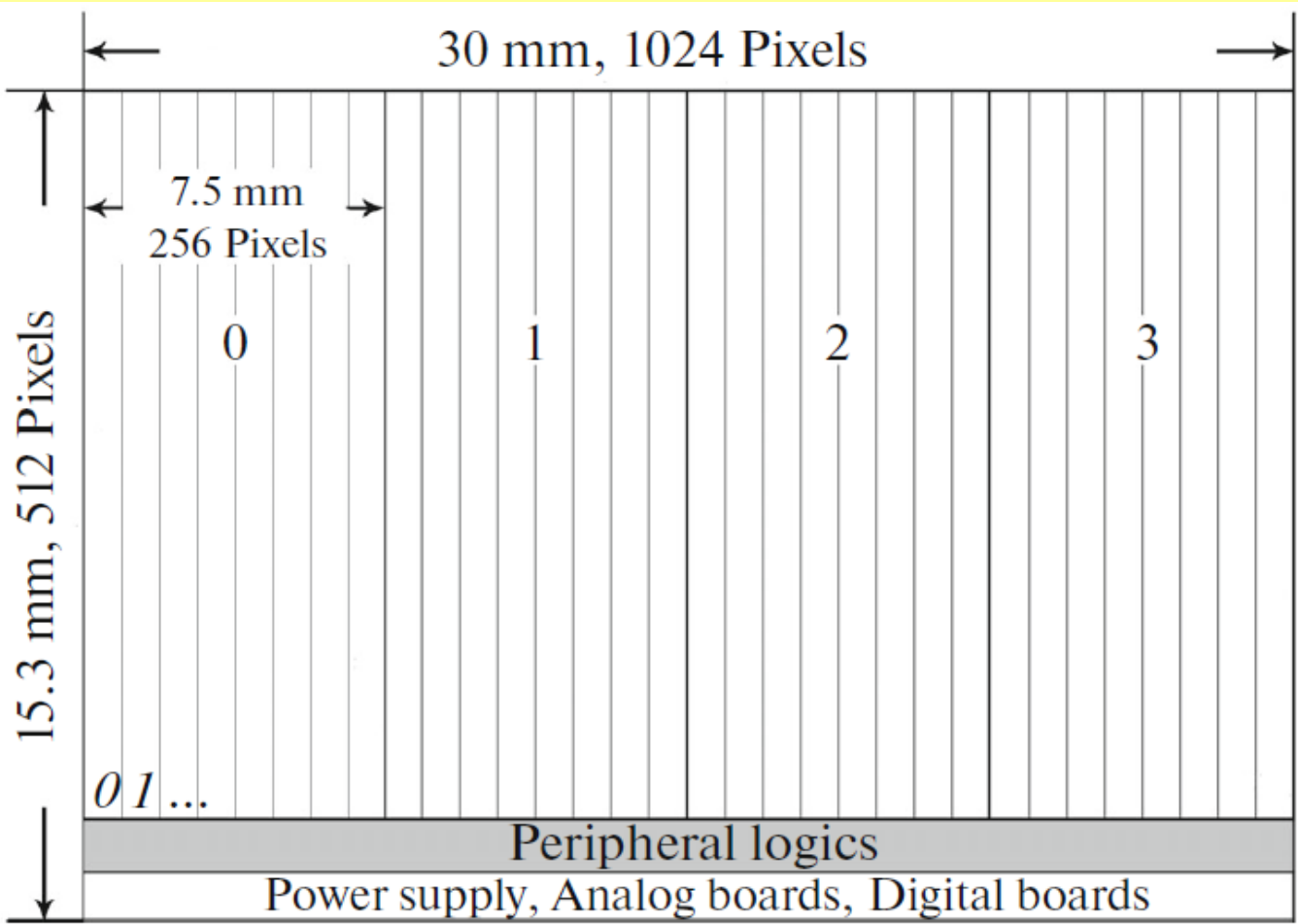
All the analogue signals required by the front-ends are generated by a set of 11 (for pALPIDE-1,2) and 14 (pALPIDE-3) on-chip digital-to-analog converters (DACs). The region readout units contain multi-event storage SRAM memories.

Hit data from the 32 region readout blocks are combined and transmitted on a parallel 8-bit output data port.

A top-level Control block provides full access to the control and status registers of the chip.



**Pixel matrix of pALPIDE-1,2**

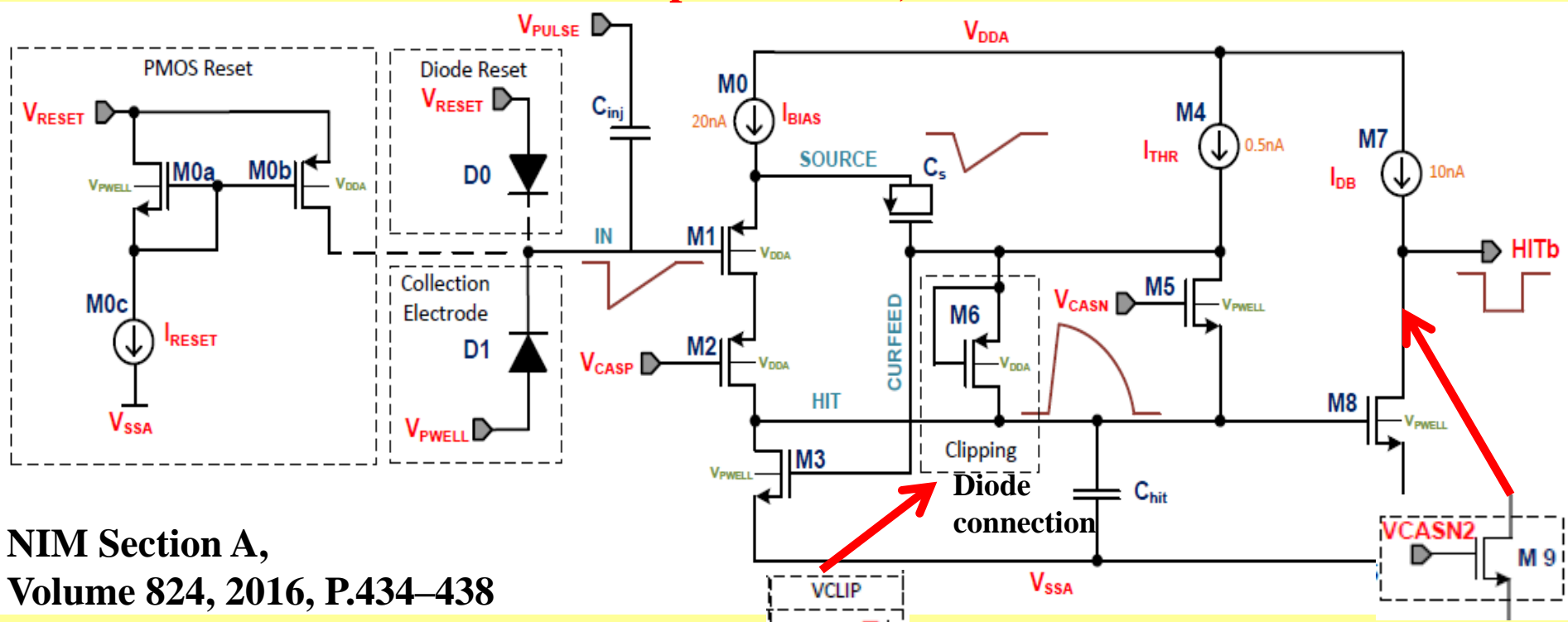


**The pixel matrix is divided into 32 regions arranged in sectors. Each sector includes 8 double columns (0, 1, 2..). In the space between each pair of double columns is a priority encoder circuit (Address-Encoder Reset-Decoder) that performs the asynchronous reading of a signal from the pixels in these columns.**

# New pixel sensors for ALICE experiment: ALICE Pixel detectors (ALPIDE family)

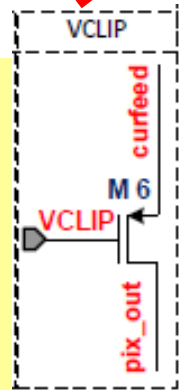
## A comprehensive scheme for the pixel front-end circuit Including all possible variations

### For pALPIDE-1,2

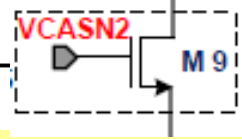


NIM Section A,  
Volume 824, 2016, P.434–438

For pALPIDE-3  
for sectors: 3,4,5,7  
add VCLIP



For pALPIDE-3  
for sectors: 0,3,4,5,7  
add VCASN-2 (M9)





# New pixel sensors for ALICE experiment: ALICE Pixel detectors (ALPIDE family)

Each sector implements a different front-end electronics

## pALPIDE-1

Sector	N-well diameter	Spacing	Reset type
0	2 um	1 um	PMOS
1	2 um	2 um	PMOS
2	2 um	2 um	Diode
3	2 um	4 um	PMOS

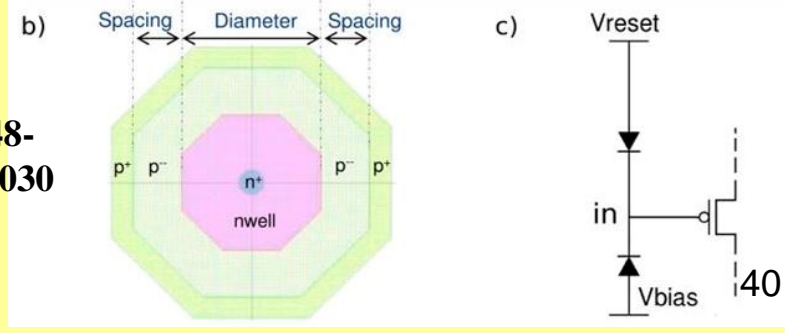
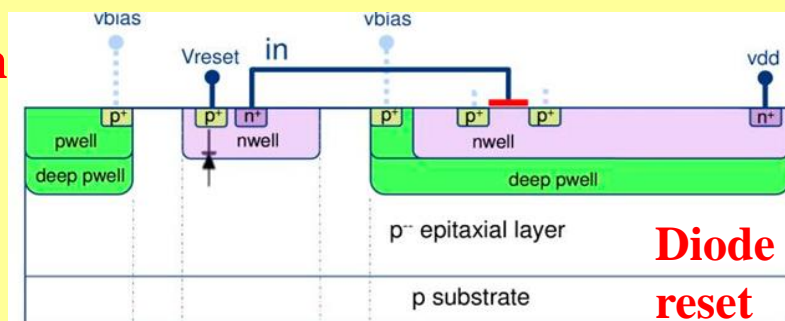
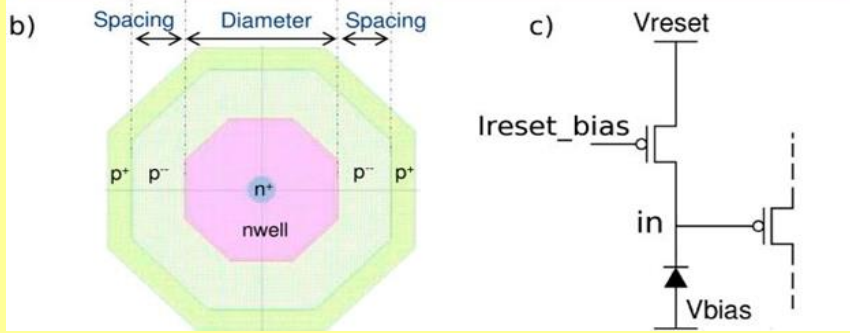
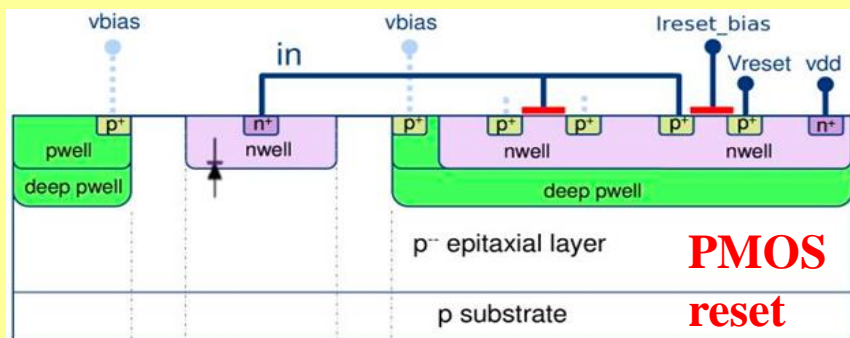
## pALPIDE-2

Sector	N-well diameter	Spacing	Reset type
0	2 um	2 um	PMOS
1	2 um	2 um	PMOS
2	2 um	4 um	PMOS
3	2 um	4 um	Diode

Sector	N-well	Spacing	Reset type
1	2 um	3 um	Diode

ALPIDE →

Collection electrode

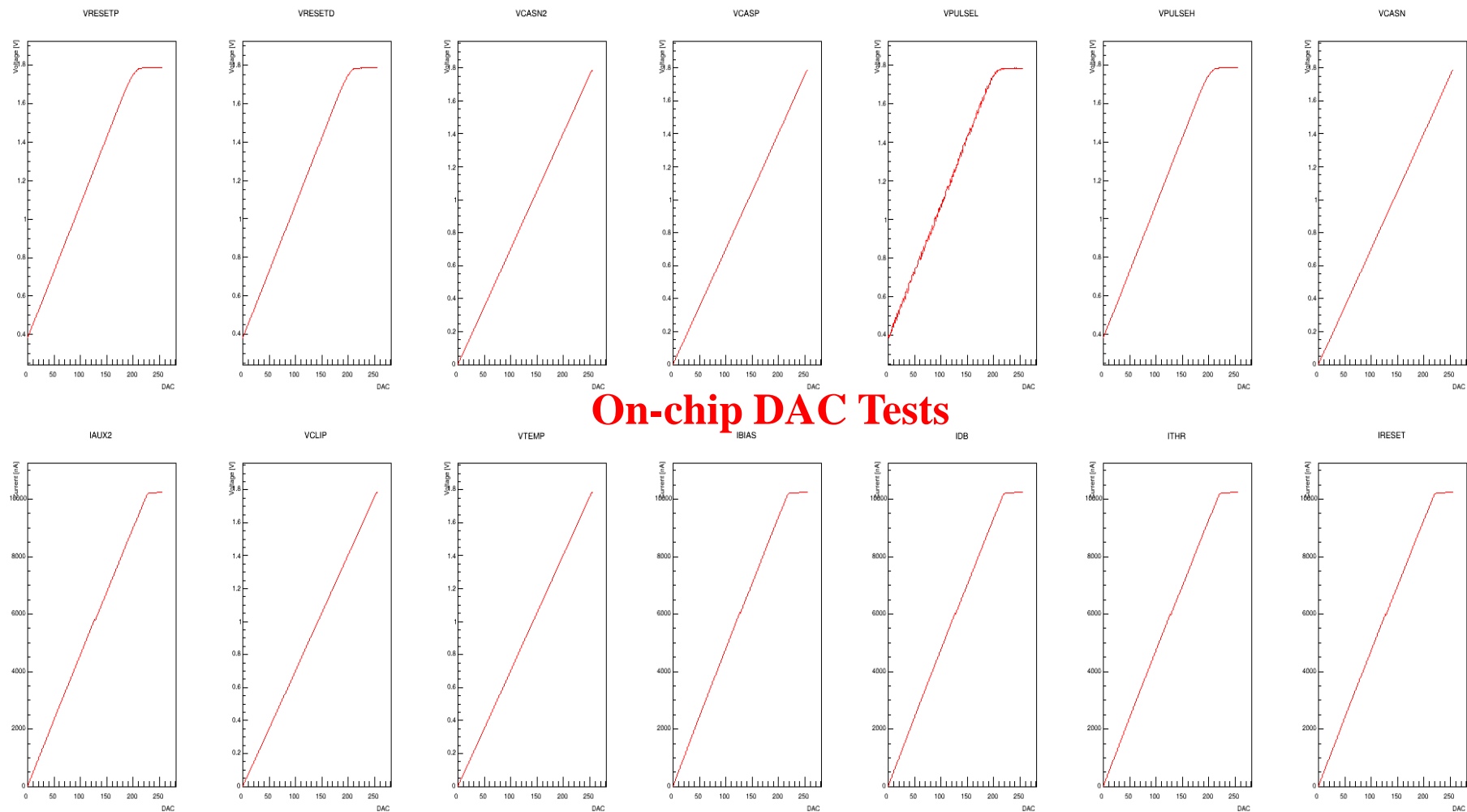


JINST

doi:10.1088/1748-0221/10/03/C03030



All next experimental results are presented for pALPIDE-3 chip



## On-chip DAC Tests

**Good linearity of voltage and current settings has been observed. The linear fit demonstrates the same slopes for all parameters for the present chip at different temperatures.**

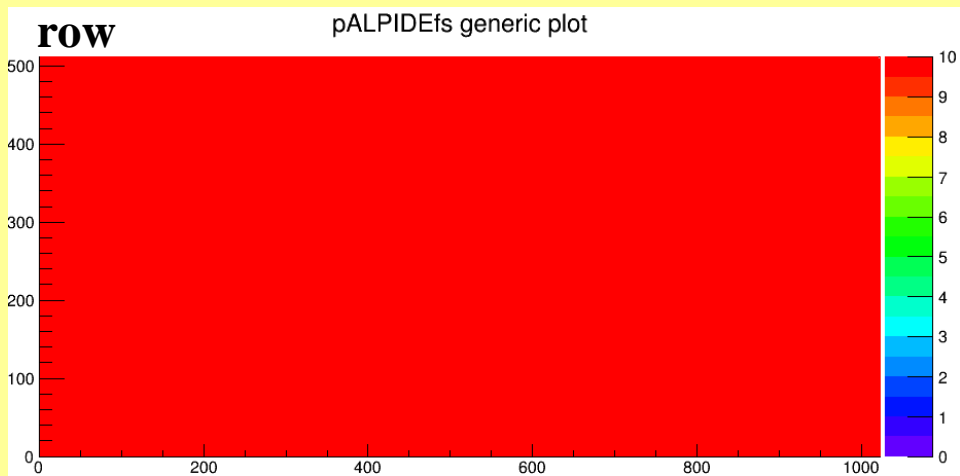


**Digital and Analogue scans. Scans generate digital or analog pulses in a number of pixels and read the hits out**

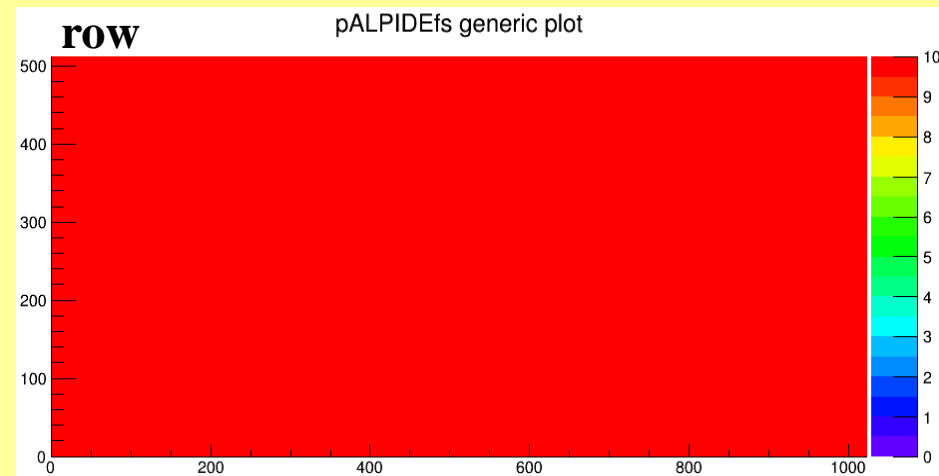
**For both tests common parameters: 10 (number of injections per pixel ) and test 100 % of the pixels**

**For analogue test an additional parameter the charge equal 350 e<sup>-</sup> was used.**

## Digital Scan



## Analogue Scan



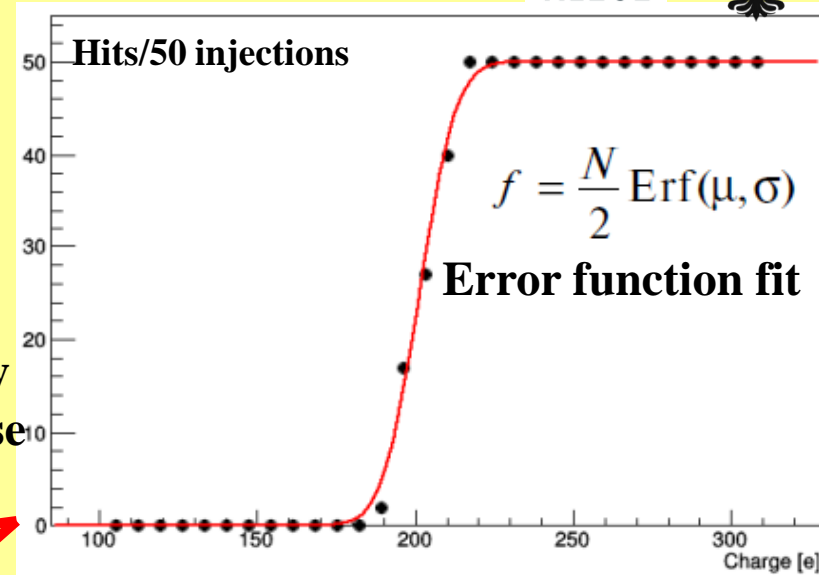
**Column**

**Good homogeneity of the pixel maps for both scans has been observed.**

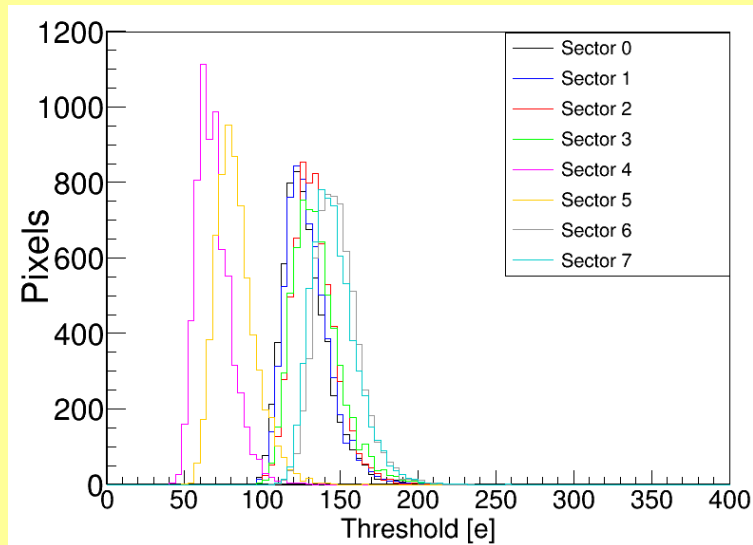
## Threshold Scan

The operational thresholds for a certain set of detector's pixels depending on the charge delivered to the chosen pixels was determined

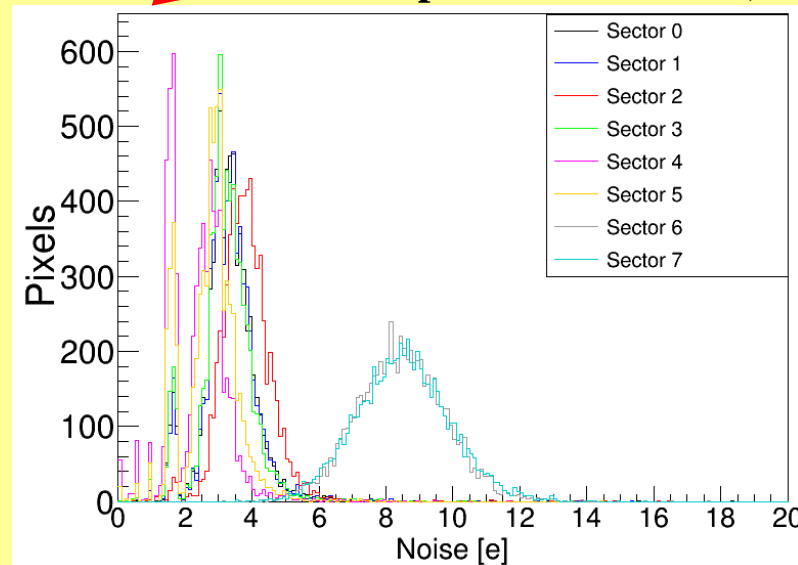
In order to extract threshold a number of charge injections with different amplitude are performed (50 points with 50 injections per point). A probability distribution of fired pixels measuring a pixel response (S-curve) has been obtained.



$N$  - number of injections,  $\mu$  - threshold value  
 $\sigma$  - temporal noise value (threshold dispersion)



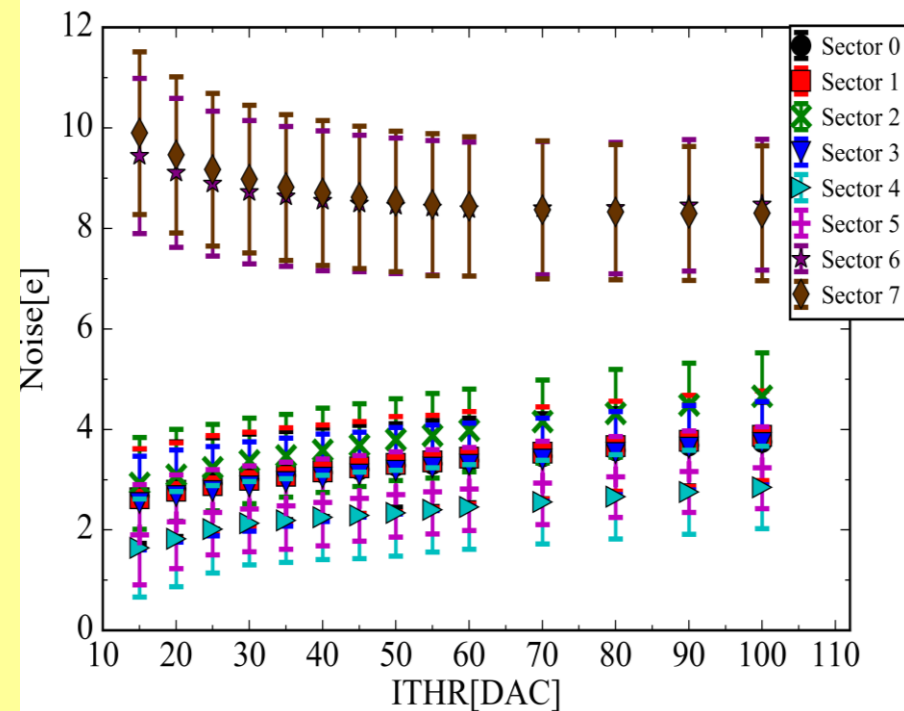
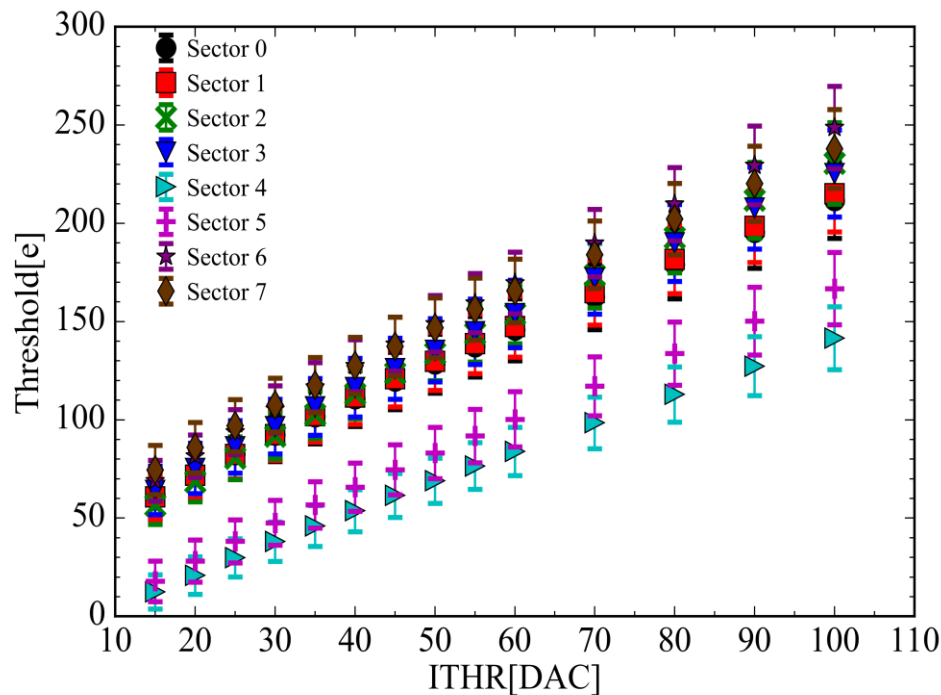
Pixel threshold distribution for 8 sectors



Temporal noise values for the pixels for 8 sectors

## Threshold Scan

1. Investigations of threshold and noise, depending on the magnitude of the  $I_{\text{THR}}$  current fed to the control transistor of a sensor at a fixed VCASN value



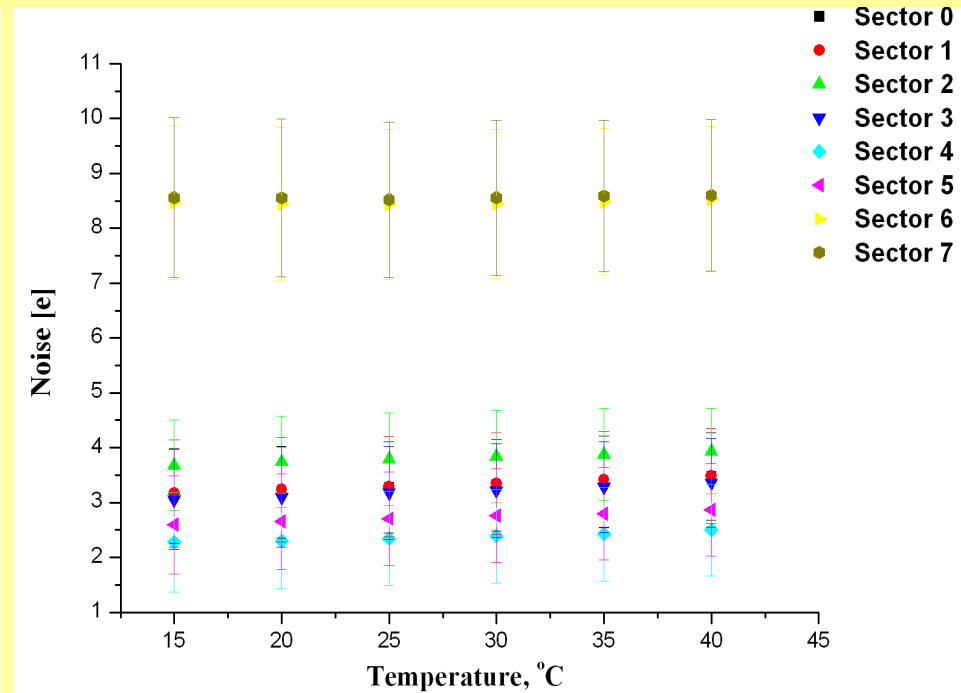
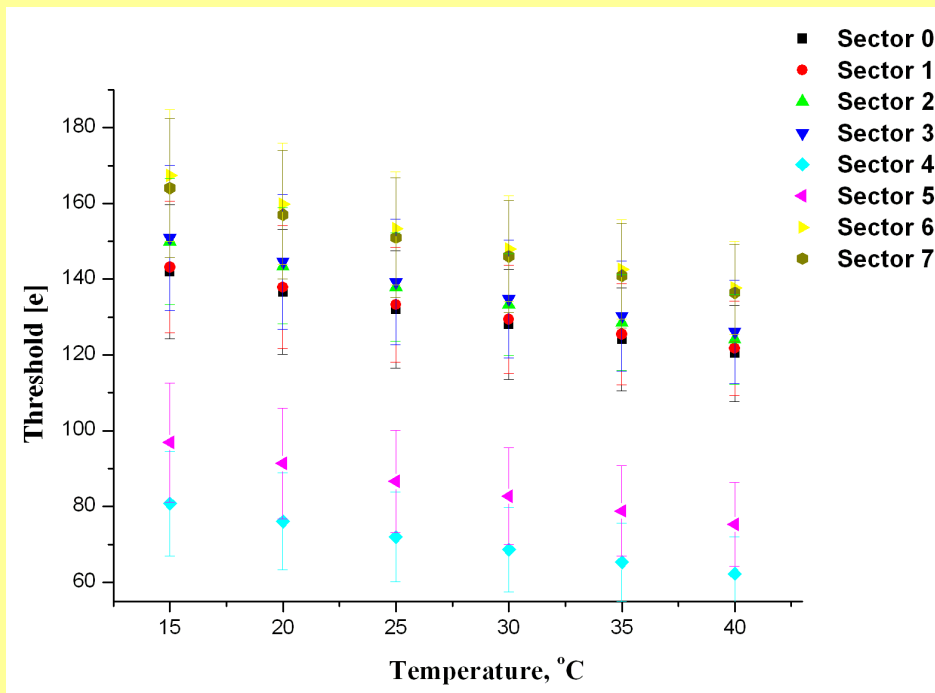
The linear dependence of the threshold values vs. Ithr has been observed for all sectors.

The threshold noise distributions are constant in the Ithr region: 40 - 60 DAC.

The thresholds in sectors 6-7 are bigger than in other sectors.

## Threshold Scan

### 1. Investigations of threshold and noise, depending on chip temperature

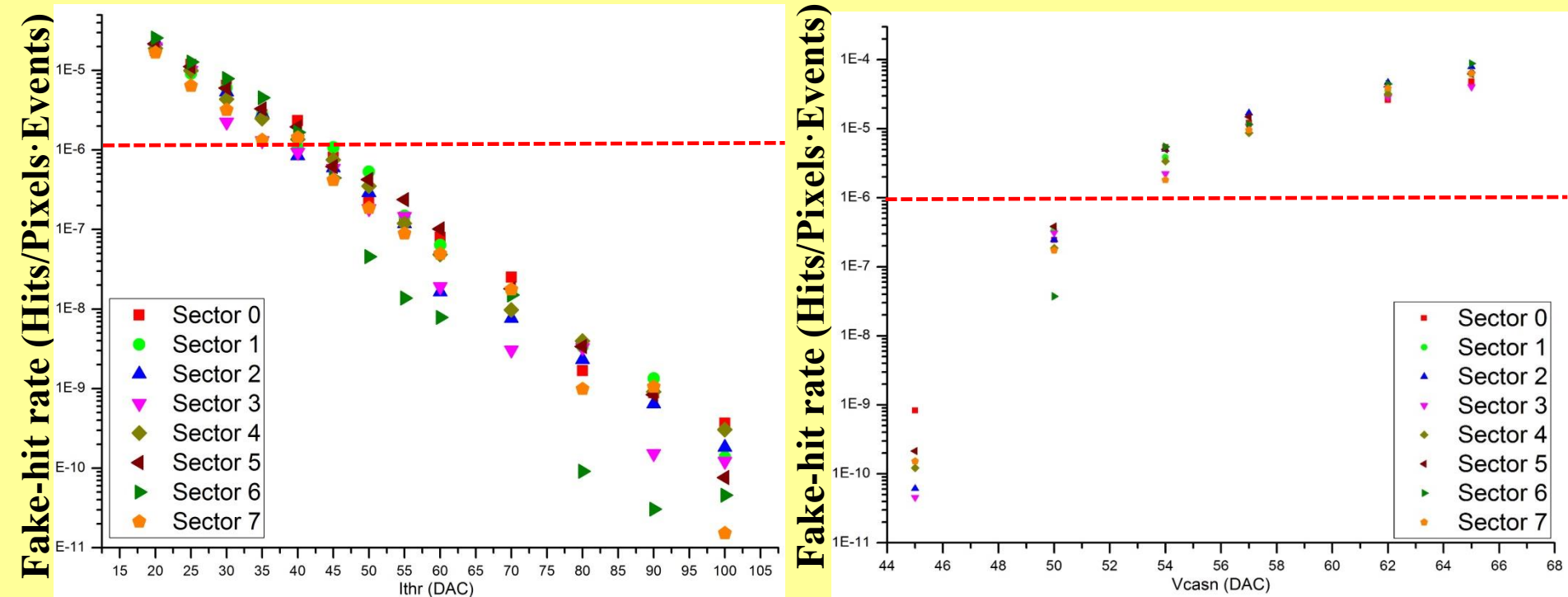


The threshold goes down slowly with the increasing of **Temperature** for all sectors.

The threshold noise distributions are constant within the entire temperature range.



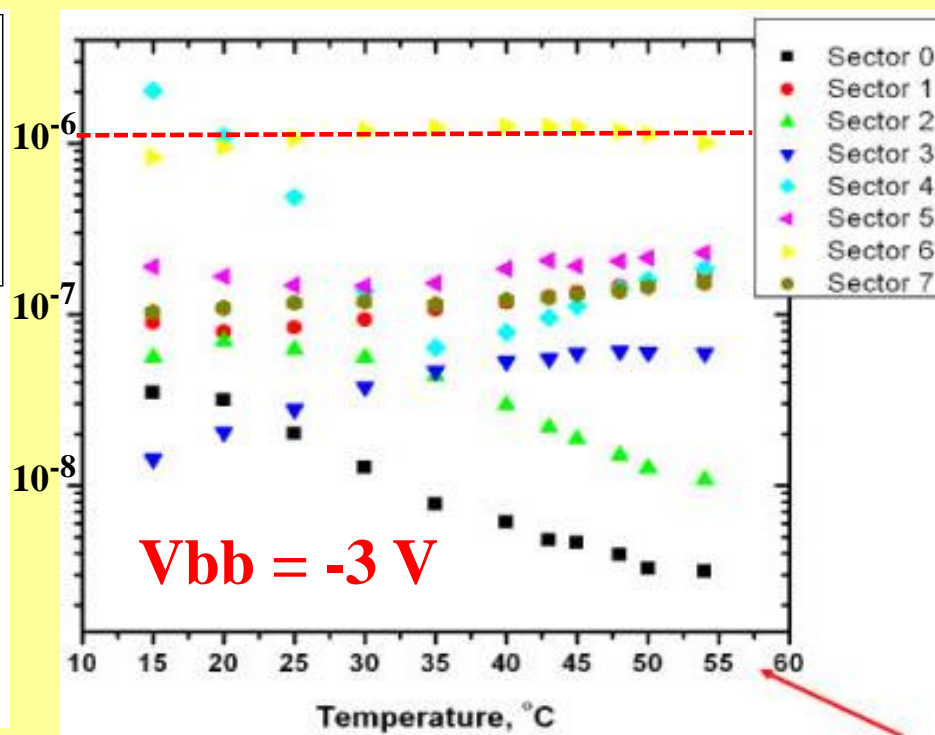
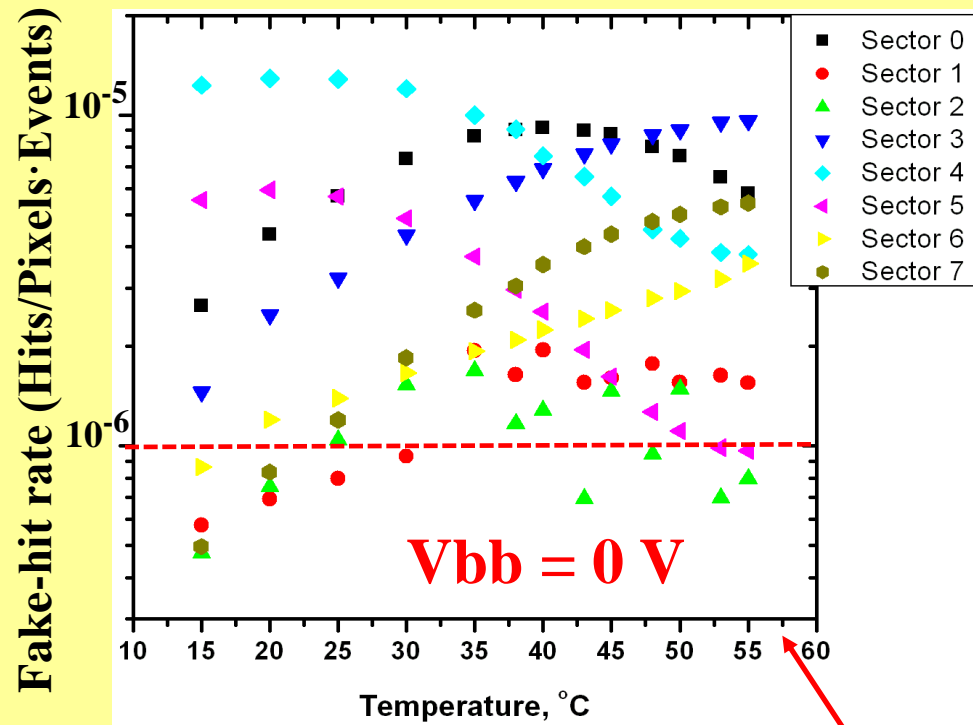
## Noise characteristics of the sensor



Noise occupancy strongly depends on the main detector settings  $I_{TH}$  and  $V_{CASN}$ . The values of these parameters which does not exceed the acceptable level of Fake hits per pixel per event (upgrade requirements) have been found.



## Noise characteristics of the sensor and its temperature dependence



Temperature limit has been reached: **56  $^{\circ}\text{C}$**

Noise occupancy strongly depends on temperature

After applying  $V_{bb}$  the acceptable level of Fake hits per pixel per event (upgrade requirements) has been reached.



## Studies with gamma and beta sources. Cluster analysis

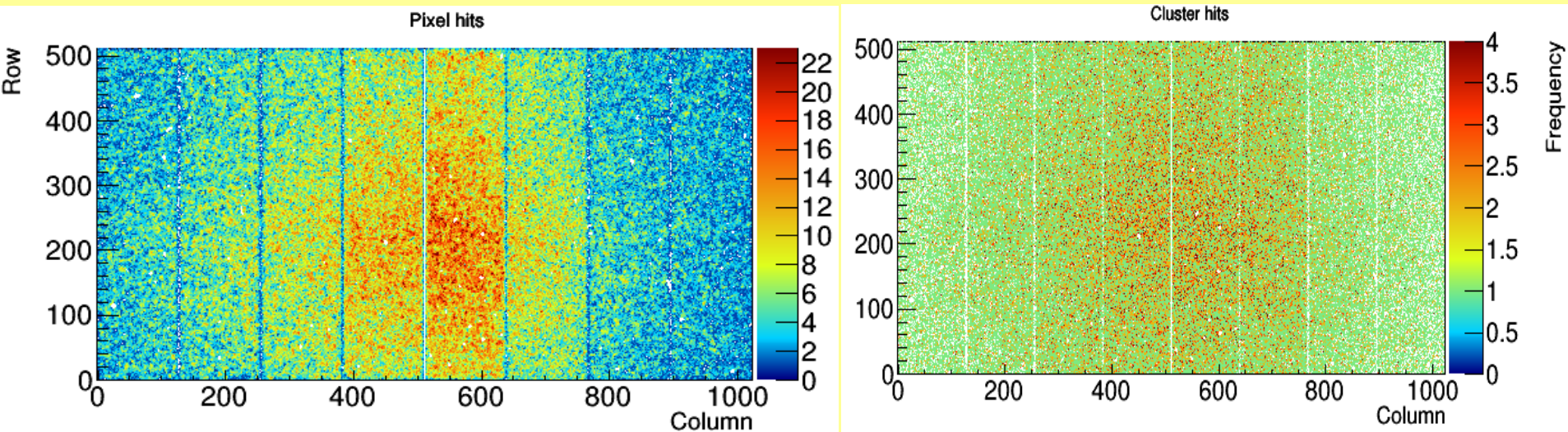
Gamma sources:  $^{241}\text{Am}$  (13.9 keV),  $^{133}\text{Ba}$  (5.64 keV),  $^{152}\text{Eu}$  (4.29),  $^{55}\text{Fe}$  (5.9 keV)

Beta sources:  $^{14}\text{C}$ ,  $^{90}\text{Sr-Y}$

A cluster is considered to be an area of a pixel matrix with a certain number of neighboring fired pixels. The number of pixels determines the cluster size.

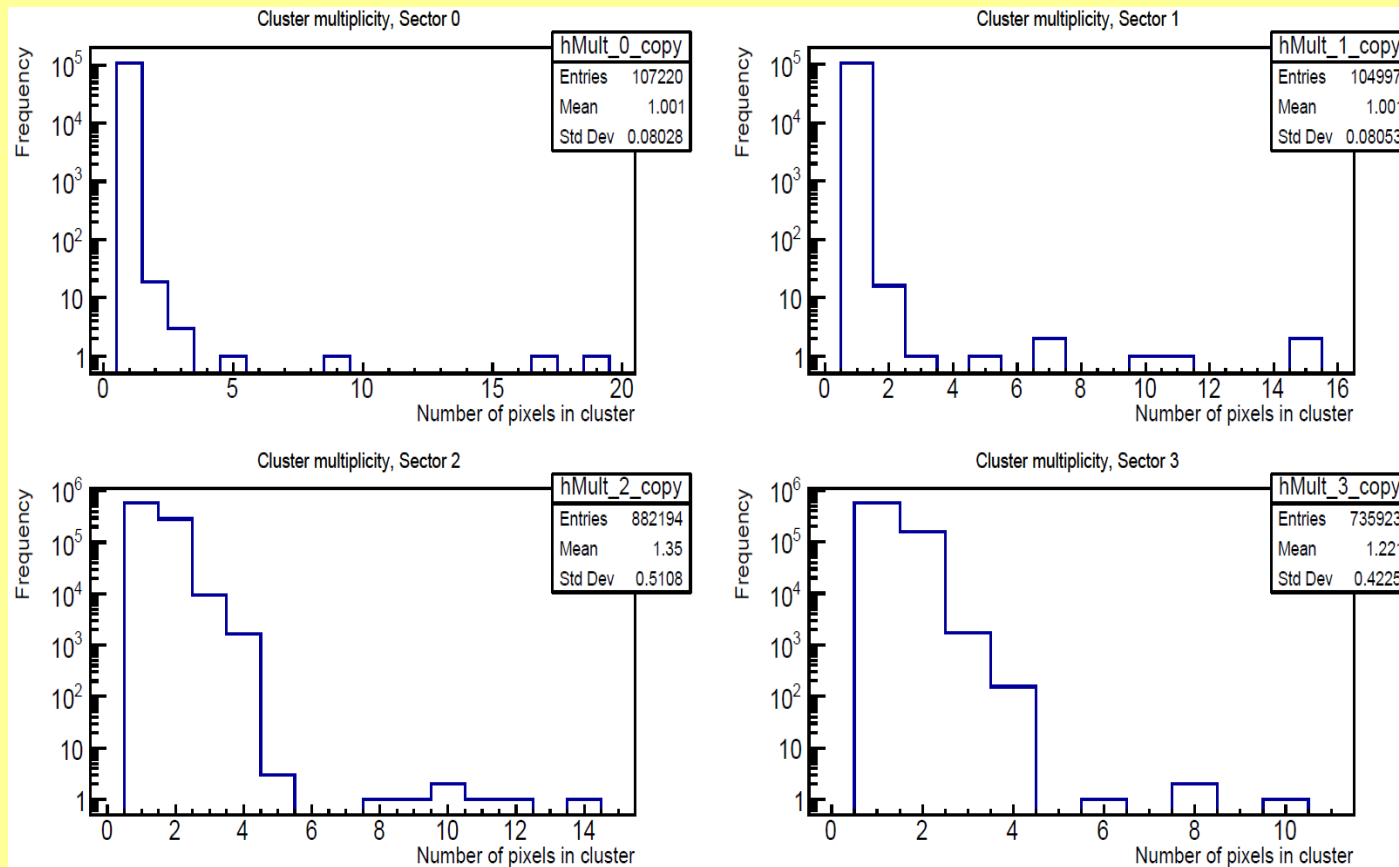
The clusters with cluster multiplicity = 1 have been included. Because in source test the noise mask (excluded hot pixels) has been applied.

## Pixel and cluster hits for $^{152}\text{Eu}$





## Cluster multiplicity in different sectors for 55Fe



**No large clusters. Average cluster multiplicity no more 1.35**



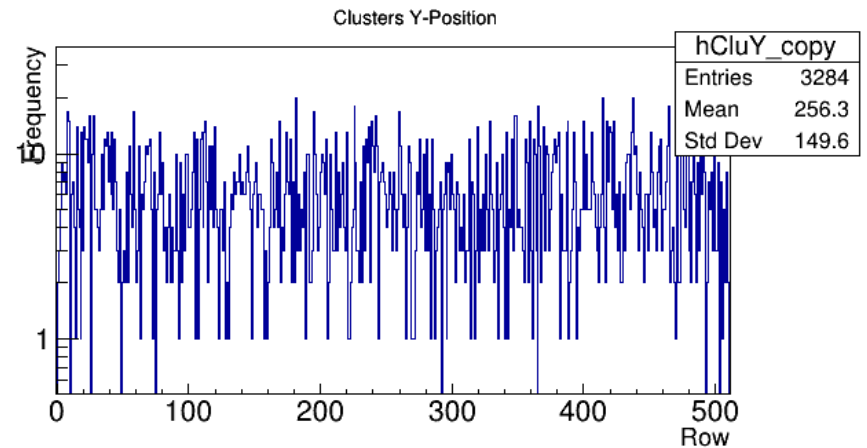
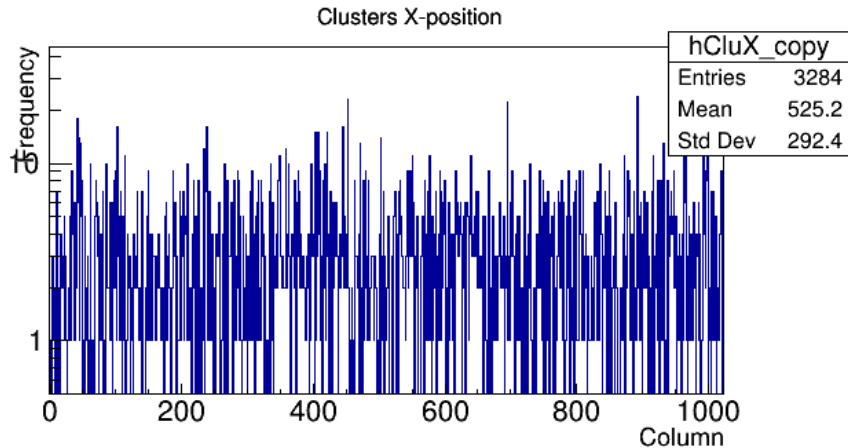
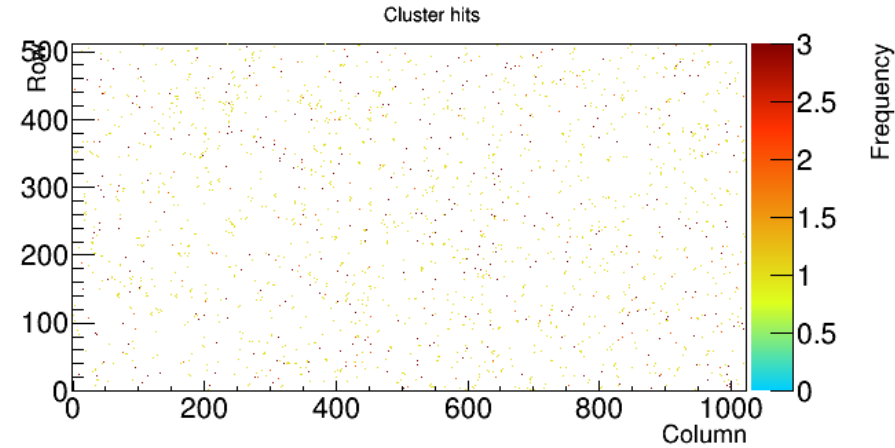
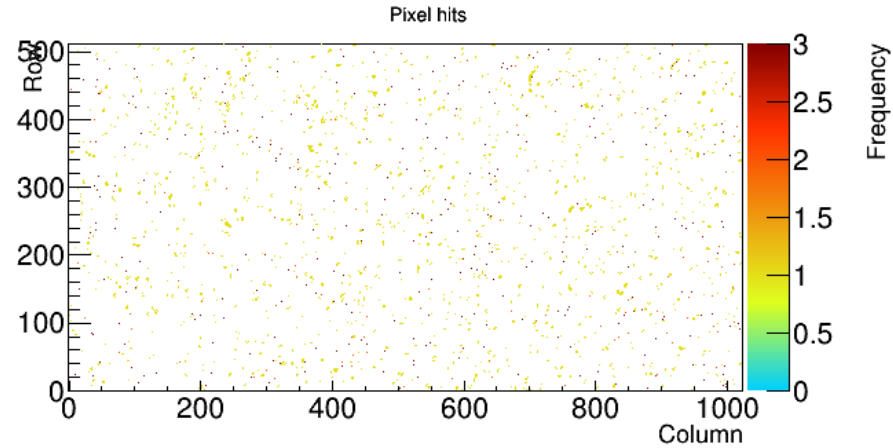
## Source test + Cluster analysis

Chip W7R12

Triggers – 2000000  
Vbb = -3V

Results for high dose irradiated chip

Masked



Source: Sr-Y, chip temperature -100 °C